

Advanced Topics for Micro-Architecture of CPU

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Outline

ex) 아톰
ex) intel + 삼성

(국내) 어렵게 놓는다거나 알지 못하는 것.

- Commerical CPU products classification ⇔ 상용 CPU 제품 분류

- Selected Commercial CPU products

↳ 고성능의 선택한 제품 (\Rightarrow cache 및 디자인 핵심)

- Key factors for analyzing micro-architecture of commercial CPU products

→ 주요 원리를 볼 것.
→ 다른 유형 것

- Introduction to ILP (Instruction Level Parallelism)

↳ 명령어 level의 병행화

- What is VLIW (Very Long Instruction Word) processor?

↳ VLIW 보다 superscalar는 훨씬 더 많아짐.
(0.1~%) (9.1~%)

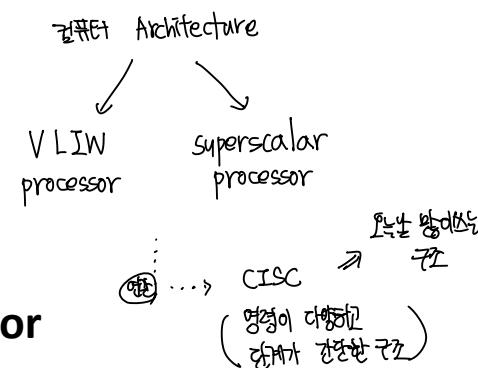
- Comparison between superscalar processor and VLIW processor

↳ 어떤 차이 때문에 superscalar를 더 많이 쓰는가!? 왜 살펴야 하는가!?

- Performance-power consumption metrics for evaluating commercial CPUs

- Relationship among fabrication technology, micro-architecture, no. of cores and cache memory

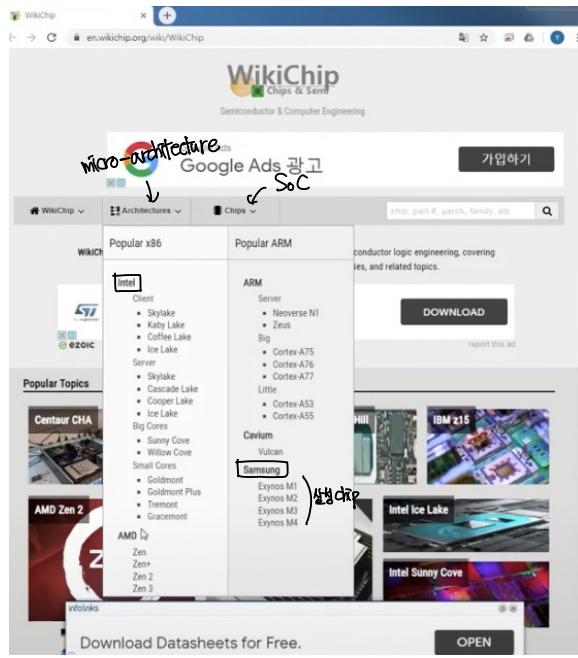
\Rightarrow 공정, micro-architecture, 코어 개수, 캐시 메모리 크기



↳ (주차) 추가 주제 예상

Commercial CPU Products Classification

<https://en.wikichip.org/wiki/WikiChip>



↳ 여기에 정복가 많음. (WikiChip)

Selected Commercial CPU Products

clk register pipeline depth 81201921.

Group#1		SoC (System-on-Chip) = CPU + GPU + HW Accelerators												
Type	Sub Type	Product Name	Release date (Year. Month)	CPU								L1 Cache	L2 Cache	L3 Cache
				Fab. Tech	Power	Name	Micro-architecture	Bit-Width	Clock Freq.	ISA	No. of Cores			
Embedded Computer Systems	Smart Phone	iPhone 4	2010. 06	45 nm	?	Apple A4	ARM Cortex-A8	32	800 MHz	ARM v7-A	1	Per-core: I-32KB, D-32KB	512KB	None
		iPhone 4s	2011. 03	32 nm	?	Apple A5	ARM Cortex-A9	32	1 GHz	ARM v7-A	2	Per-core: I-32KB, D-32KB	1MB shared	None
		iPhone 5s	2013. 09	28 nm	2~3 W	Apple A7	Apple Cyclone	64	1.3 GHz	ARM v8.0-A	2	Per-core: I-64KB, D-64KB	1MB shared	4MB shared by the entire SoC
		iPhone 6s	2015. 09	16 nm	?	Apple A9	Apple Twister	64	1.85 GHz	ARM v8.0-A	2	Per-core: I-64KB, D-64KB	3MB shared	4MB shared by the entire SoC
		iPhone 7	2016. 09	16 nm	?	Apple A10 Fusion	2 x Hurricanes for high performance 2 x Zephyr for energy efficiency	64	2.34 GHz Perf. depth	ARM v8.1-A	4	Per-core: I-64KB, D-64KB Per-core: I-32KB, D-32KB	3MB shared 1MB shared	4MB shared by the entire SoC
		Galaxy S8	2017. 04	10 nm	?	Exynos 8895	4 x Mongoose2 (M2) for high performance 4 x Cortex-A53 for energy efficiency	64	2.3 GHz 1.7 GHz	ARM v8-A	8	Per-core: I-64KB, D-32KB Per-core: I-32KB, D-32KB	2MB shared 256KB shared	None
		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	2 x Monsoon for high performance 4 x Mistral for energy efficiency	64	2.39 GHz 1.42 GHz	ARM v8.2-A	6	Per-core: I-64KB, D-64KB Per-core: I-32KB, D-32KB	8MB shared 1MB shared	None
		iPhone XS	2018. 09	7 nm	?	Apple A12	2 x Vortex for high performance 4 x Tempest for energy efficiency	64	2.49 GHz 1.52 GHz	ARM v8.3-A	6	Per-core: I-128KB, D-128KB Per-core: I-32KB, D-32KB	8MB shared 2MB shared	None
		iPhone 11 Pro	2019. 09	7 nm	?	Apple A13	2 x Lightning for high performance 4 x Thunder for energy efficiency	64	2.66 GHz 1.82 GHz	ARM v8.4-A	6	Per-core: I-128KB, D-128KB Per-core: I-32KB, D-48KB	8MB shared 4MB shared	None
Tablet PC	HP x2 210 G2 3ML39PA	2018. 02	14 nm	2W	Intel Atom® Processor x5-Z8350	Airmont	64	1.44 ~ 1.92 GHz	x86-64	4	Per-core: I-32KB, D-24KB	2MB (1MB shared by 2 cores)	None	

Selected Commercial CPU Products

Group#2

Type	Sub Type	Product Name	Release date (Year. Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators													
				Fab. Tech	Power	Name	CPU								L1 Cache	L2 Cache	L3 Cache
							Micro-architecture	Bit-Width	Clock Freq.	ISA	No. of Cores						
Embedded Computer Systems	Smart Phone	Galaxy S9	2018. 03	10 nm	?	Exynos 9810	4 x Meerkat (M3) for high performance	64	2.9 GHz	ARM v8-A	8	Per-core: I-64KB, D-64KB	Per-core: 512KB	4MB shared			
							4 x Cortex-A55 for energy efficiency		1. 9 GHz	ARM v8.2-A		Per-core: I-32KB, D-32KB	256KB Shared				
		Galaxy Note10	2019. 08	7 nm	?	Exynos 9825	2 x Cheetah (M4) for high performance	64	2.73 GHz	ARM v8.2-A	8	Per-core: I-64KB, D-64KB	Per-core: 512KB	4MB shared			
							2 x Cortex-A75 for moderate performance		2.4 GHz			Per-core: I-64KB, D-64KB	Per-core: 256KB				
	General PC	SAMSUNG NT900X3N-K59SS	2015. 03	14 nm	15W	Intel® Core™ i5-7200U	7th Gen. Kaby Lake		2.5 ~ 3.1 GHz	x86 -64	2	Per-core: I-32KB, D-32KB	Per-core: 256KB	3MB shared by 2 cores and GPU			
		LG GRAM 17ZD90N-VX70K	2019. 12	10 nm	15W	Intel® Core™ i7-1065G7	10th Gen. Ice Lake		1.3 ~ 3.9 GHz	x86 -64	4	Per-core: I-32KB, D-48KB	Per-core: 512KB	8MB shared by 4 cores and GPU			
		SAMSUNG DB400T6B	2015. 03	14 nm	65W	Intel® Core™ i7-6700	6th Gen. Skylake		3.4 ~ 4 GHz	x86 -64	4	Per-core: I-32KB, D-32KB	Per-core: 256KB	8MB shared by 4 cores and GPU			
		Danawa 190721	2019. 07	14 nm	95W	Intel® Core™ i7-9700K	9th Gen. Coffee Lake		3.6 ~ 4.9 GHz	x86 -64	8	Per-core: I-32KB, D-32KB	Per-core: 256KB	12MB shared by 4 cores and GPU			
Server/ Workstation	Floating License/ Data Sever	TYAN KFT46	2011. 09	32 nm	80W	Intel® Xeon ® E5606	Westmere	64	2.13 GHz	x86 -64	4	Per-core: I-32KB, D-32KB	Per-core: 256KB	8MB shared by 4 cores			
							WikiChip					Per-core: I-32KB, D-32KB	Per-core: 256KB				
	High performance Workstation	Lenovo ThinkStation P500TW 850W	2015. 07	22 nm	140W	Intel® Xeon ® E5-1630 v3	Haswell		3.7 ~ 3.8 GHz	x86 -64	4	Per-core: I-32KB, D-32KB	Per-core: 256KB	10MB shared by 4 cores			
		TYAN TAKO-KQT44	2020. 04	14 nm	150W	Intel® Xeon Gold 6226R	Cascade Lake		2.9 ~ 3.9 GHz	x86 -64	16	Per-core: I-32KB, D-32KB	Per-core: 1MB	22MB shared by 16 cores			

여기서

Core가 많아져
(3 코어로 확장된 제품(화이트박스))

여기서는
여러는 많아짐.

Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

이안으 들어가실 것인 .

Micro-architecture						
Name	Intro' date (Year. Month)	Type	Spec. of Superscalar processor			
			No. of Issues (Decodes)	Out of order execution	Branch prediction (speculation)	No. of Execution ports
Separate I, D2, LLC	2011	Pipeline fetch	4	4	4	4

The diagram illustrates the relationship between different instruction-level parallelism (ILP) techniques:

- VLIW** (Vertical List Instruction Word) is at the top.
- Superscalar** is in the middle, connected by a horizontal line.
- SIMD** (Single Instruction Multiple Data) is at the bottom, also connected by a horizontal line.
- A large downward-pointing arrow on the left indicates a flow from VLIW down to Superscalar and SIMD.
- An upward-pointing arrow on the right indicates a flow from SIMD up to Superscalar.
- Text annotations include "어디서나" (anywhere) and "제한적" (restricted) pointing to VLIW; "제한적" (restricted) and "제한적" (restricted) pointing to SIMD; and "제한적" (restricted) pointing to Superscalar.

6 가지를 기준으로
정의해 성능을 분석할 수 있음.
(예비, 차이, cache의 구성 관리정책에 성능이 어떤 종류)

Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

Group#1		Product Name	Release date (Year. Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators										
Type	Sub Type			Fab. Tech	Power	Name	CPU					Micro-architecture		
							Name	Intro' date (Year. Month)	① Type	② No. of Issues (Decodes)	③ Out of order execution	④ Branch prediction (speculation)	⑤ No. of Execution ports	⑥ Pipeline depth
Embedded Computer Systems	Smart phone	iPhone 4	2010. 06	45 nm	?	Apple A4	ARM Cortex-A8	2005. ?	Super scalar	2	No	Yes	2	13
		iPhone 4s	2011. 03	32 nm	?	Apple A5	ARM Cortex-A9	2007. ?	Super scalar	2	Yes	Yes	3	11
		iPhone 5s	2013. 09	28 nm	2~3 W	Apple A7	Apple Cyclone	2013. ?	Super scalar	6	Yes	Yes	9	16
		iPhone 6s	2015. 09	16 nm	?	Apple A9	Apple Twister	2015. ?	Super scalar	6	Yes	Yes	9	16
		iPhone 7	2016. 09	16 nm	?	Apple A10 Fusion	2 x Hurricanes for high performance	2016. ?	Super scalar	6	Yes	Yes	9	16
							2 x Zephyr for energy efficiency	2016. ?		3	Yes	Yes	5	12
		Galaxy S8	2017. 04	10 nm	?	Exynos 8895	4 x Mongoose2 (M2) for high performance	2017. 02	Super scalar	4	Yes	Yes	8	13
							4 x Cortex-A53 for energy efficiency	2012. 10		2	No	Yes	2	8
		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	2 x Monsoon for high performance	2017. ?	Super scalar	7	Yes	Yes	13	16
							4 x Mistral for energy efficiency	2017. ?		3	Yes	Yes	5	12
		iPhone XS	2018. 09	7 nm	?	Apple A12	2 x Vortex for high performance	2018. ?	Super scalar	7	Yes	Yes	13	16
							4 x Tempest for energy efficiency	2018. ?		3	Yes	Yes	5	12
		iPhone 11 Pro	2019. 09	7 nm	?	Apple A13	2 x Lightning for high performance	2019. ?	Super scalar	7	Yes	Yes	13	16
							4 x Thunder for energy efficiency	2019. ?		3	Yes	Yes	5	12
Tablet PC	HP x2 210 G2 3ML39PA	2018. 02	14 nm	2W	Intel Atom® Processor x5-Z8350	Airmont	2015. ?	Super scalar	2	Yes	Yes	5	12-14	

7

Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

Group#2		Product Name	Release date (Year. Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators											
Type	Sub Type			Fab. Tech	Power	Name	CPU								
							Micro-architecture				Spec. of Superscalar processor				
							Name	Intro' date (Year. Month)	Type	No. of Issues (Decodes)	Out of order execution	Branch prediction (speculation)	No. of Execution ports	Pipeline depth	
Embedded Computer Systems	Smart Phone	Galaxy S9	2018. 03	10 nm	?	Exynos 9810	4 x Meerkat (M3) for high performance	2018. ?	Super scalar	6	Yes	Yes	12	15	
							4 x Cortex-A55 for energy efficiency	2017. 05		2	No	Yes	2	8	
		Galaxy Note10	2019. 08	7 nm	?	Exynos 9825	2 x Cheetah (M4) for high performance	2019. ?	Super scalar	6	Yes	Yes	12	15	
							2 x Cortex-A75 for moderate performance	2017. 05		3	Yes	Yes	8	11-13	
							4 x Cortex-A55 for energy efficiency	2017. 05		2	No	Yes	2	8	
General PC	Laptop	SAMSUNG NT900X3N-K59SS	2017. 07	14 nm	15W	Intel® Core™ i5-7200U	7th Gen. Kaby Lake	2016. 08	Super scalar	5	Yes	Yes	8	14-19	
		LG GRAM 17ZD90N-VX70K	2019. 12	10 nm	15W	Intel® Core™ i7-1065G7	10th Gen. Ice Lake	2019. 05	Super scalar	5	Yes	Yes	10	14-19	
	Desktop	SAMSUNG DB400T6B	2015. 12	14 nm	65W	Intel® Core™ i7-6700	6th Gen. Skylake	2015. 08	Super scalar	5	Yes	Yes	8	14-19	
		Danawa 190721	2019. 07	14 nm	95W	Intel® Core™ i7-9700K	9th Gen. Coffee Lake	2017. 10	Super scalar	5	Yes	Yes	8	14-19	
Server/ Workstation	Floating License/ Data Sever	TYAN KFT46	2011. 09	32 nm	80W	Intel® Xeon ® E5606	Westmere	2010. 01	Super scalar	4	Yes	Yes	6	14-19	
	WikiChip														
	Block diagram														
	High performance Workstation	Lenovo ThinkStation P500TW 850W	2015. 07	22 nm	140W	Intel® Xeon ® E5-1630 v3	Haswell	2013. 06	Super scalar	4	Yes	Yes	8	14-19	
		TYAN TAKO-KQT44	2020. 04	14 nm	150W	Intel® Xeon Gold 6226R	Cascade Lake	2019. ?	Super scalar	5	Yes	Yes	8	14-19	

Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– What is Pipeline (Pipelining)?

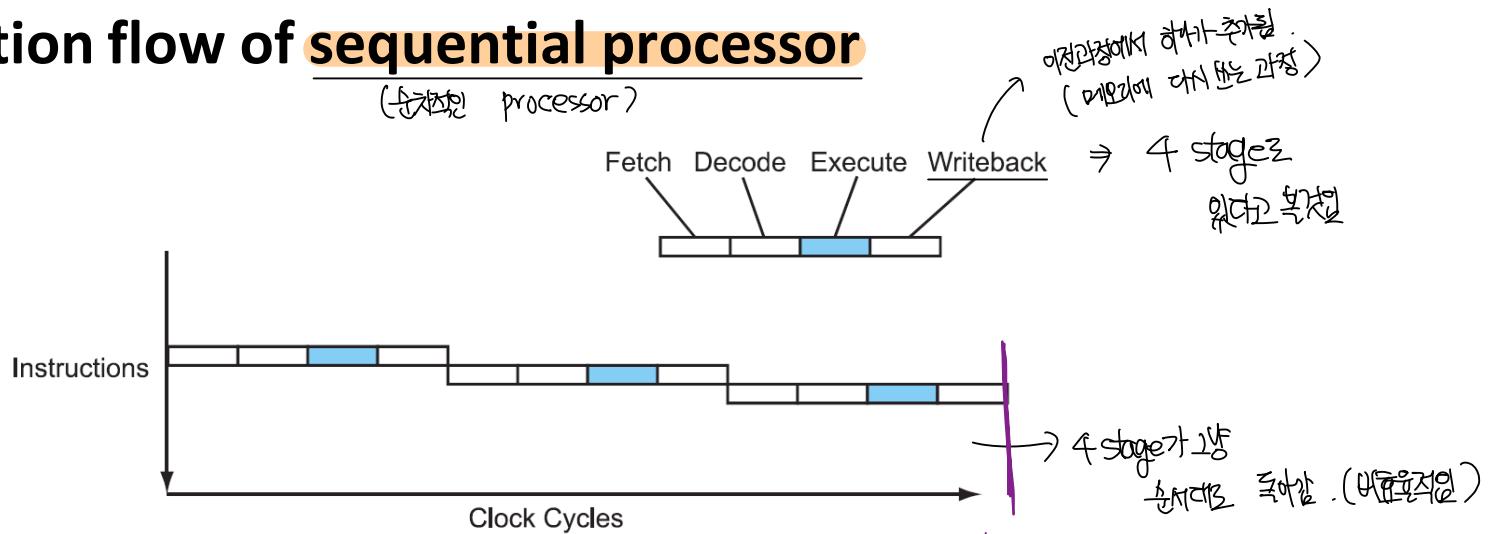
pipelining은 무엇인가!?

Group#1			Group#2		Product Name	Release date (Year.)	System-on-Chip			CPU					Micro-architecture			Spec. of Superscalar processor		
							Fab.	Power	Name	System-on-Chip		CPU			Micro-architecture		Spec. of Superscalar processor			
Type	Sub Type	Product Name	Release date (Year. Month)	Fab. Tech	Power	Name	System-on-Chip		CPU			Micro-architecture		Spec. of Superscalar processor			Arch. Generation	No. of Execution ports	Pipeline depth	
Embedded Computer Systems	Smart phone	iPhone 4	2010. 06	45 nm	?	Apple A4	ARM Cortex-A8	2005. ?	Super scalar	2	No	Yes	2	13	12	15				
		iPhone 4s	2011. 03	32 nm	?	Apple A5	ARM Cortex-A9	2007. ?	Super scalar	2	Yes	Yes	3	11	2	8				
		iPhone 5s	2013. 09	28 nm	2~3 W	Apple A7	Apple Cyclone	2013. ?	Super scalar	6	Yes	Yes	9	16	12	15				
		iPhone 6s	2015. 09	16 nm	?	Apple A9	Apple Twister	2015. ?	Super scalar	6	Yes	Yes	9	16	8	11-13				
		iPhone 7	2016. 09	16 nm	?	Apple A10 Fusion	2 x Hurricanes for high performance	2016. ?	Super scalar	6	Yes	Yes	9	16	2	8				
		Galaxy S8	2017. 04	10 nm	?		2 x Zephyr for energy efficiency	2016. ?		3	Yes	Yes	5	12	8	14-19				
		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	4 x Mongoose2 (M2) for high performance	2017. 02	Super scalar	4	Yes	Yes	8	13	8	14-19				
		iPhone XS	2018. 09	7 nm	?		4 x Cortex-A53 for energy efficiency	2017. 10		2	No	Yes	2	8	6	14-19				
		iPhone 11 Pro	2019. 09	7 nm	?	Apple A12	2 x Monsoon for high performance	2017. ?	Super scalar	7	Yes	Yes	13	16	8	14-19				
		Tablet PC	HP x2 210 G2 3ML3PA	2018. 02	14 nm	2W	Intel Atom® Processor x5-Z8350	4 x Mistral for energy efficiency		3	Yes	Yes	5	12	8	14-19				
		iPhone 12 Pro	2020. 10	5 nm	?	2 x Vortex for high performance	2018. ?	Super scalar	7	Yes	Yes	13	16	8	14-19					
		iPhone 13 Pro	2021. 09	4 nm	?	4 x Tempest for energy efficiency	2018. ?		3	Yes	Yes	5	12	8	14-19					
		iPhone 14 Pro	2022. 09	3 nm	?	2 x Lightning for high performance	2019. ?	Super scalar	7	Yes	Yes	13	16	12-14	12-14					
		iPhone 15 Pro	2023. 09	2 nm	?	4 x Thunder for energy efficiency	2019. ?		3	Yes	Yes	5	12							

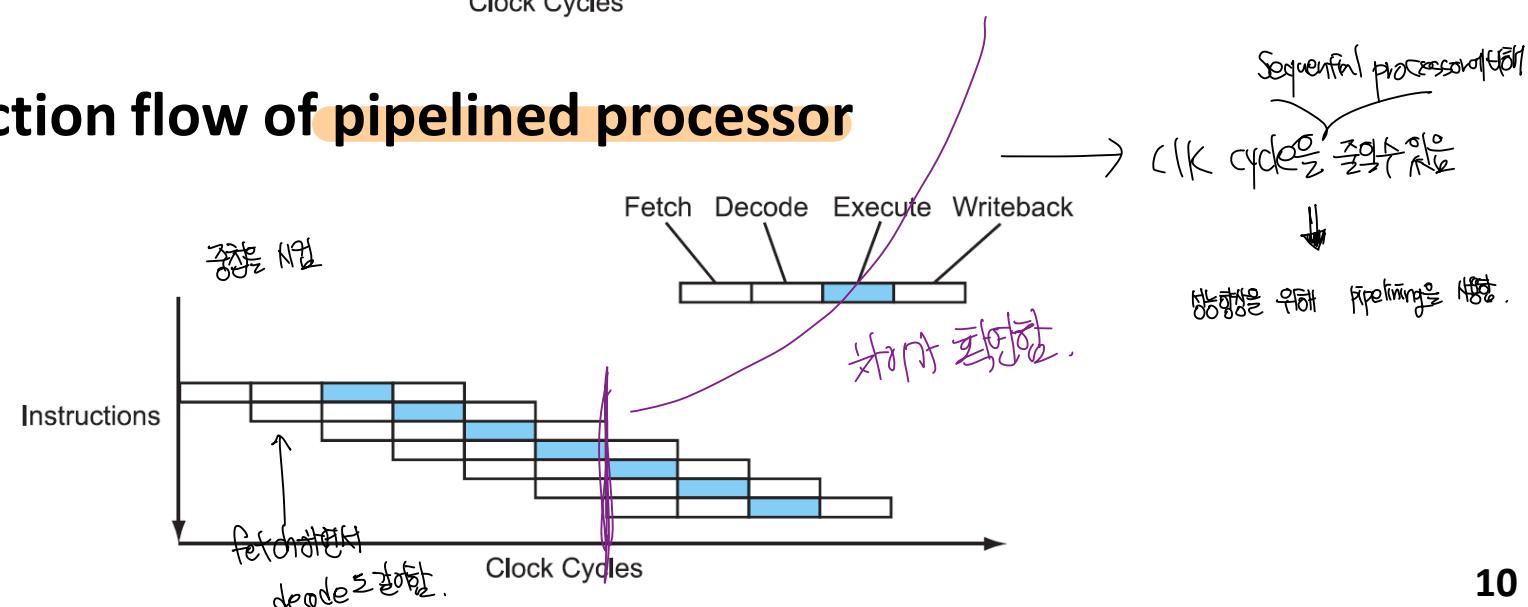
Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– What is Pipeline (Pipelining)?

- Instruction flow of sequential processor



- Instruction flow of pipelined processor

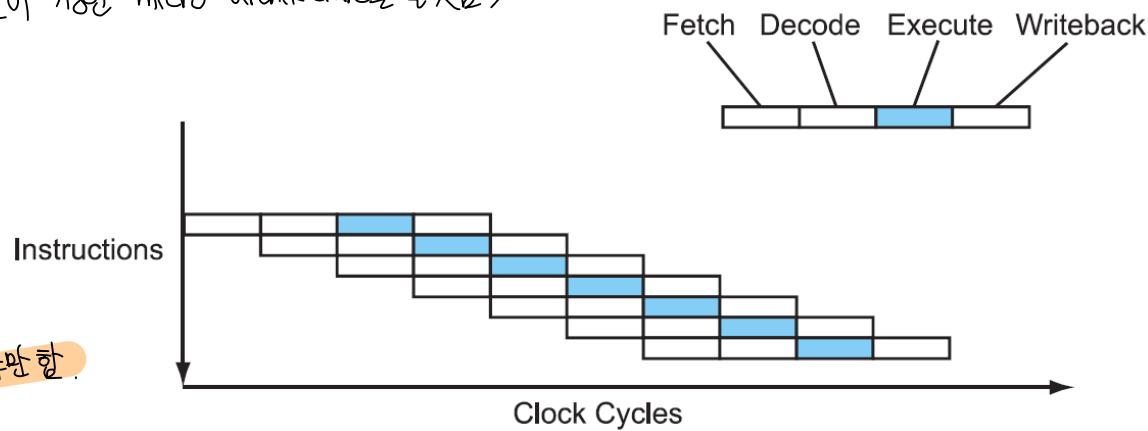


Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

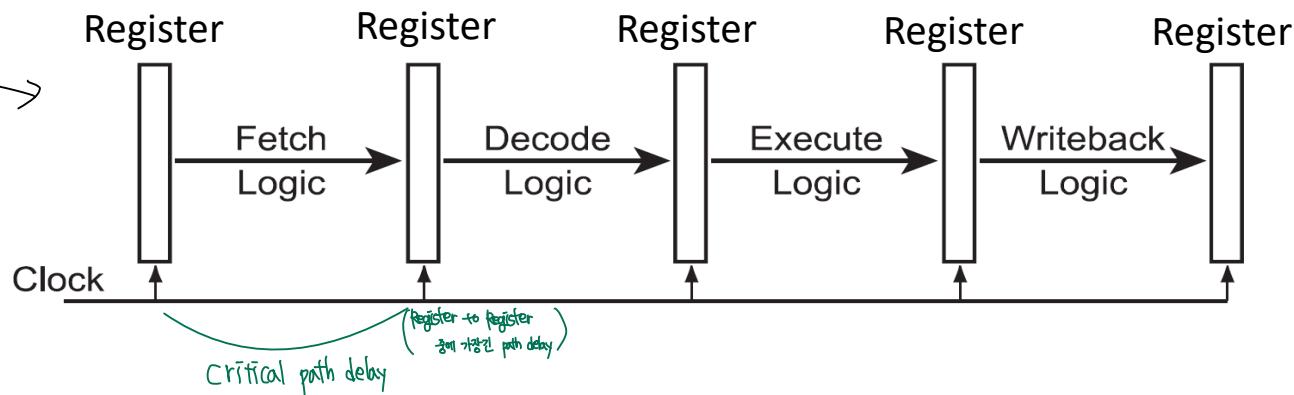
– What is Pipeline (Pipelining)?

- Pipelined micro-architecture

(pipelining이 가능한 micro-architecture를 봅시다)



* architecture
다음과 같이 생각하면 pipelining이 가능.



Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– What is Pipeline (Pipelining)?

- **Deeper Pipelines – Superpipelining**

- The clock speed is limited by the delay length of the longest, slowest stage in the pipeline.
- The logic gates that make up each stage can be subdivided for converting the pipeline into a deeper super-pipeline with a larger number of shorter stages.
- Then the whole processor can be run at a higher clock speed.
⇨ 그 결과, 더 빠른 클럭으로 동작할 수 있음.

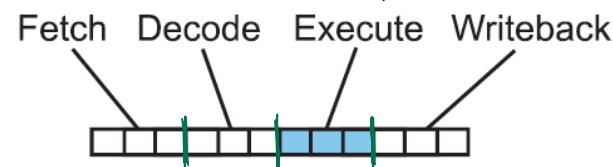
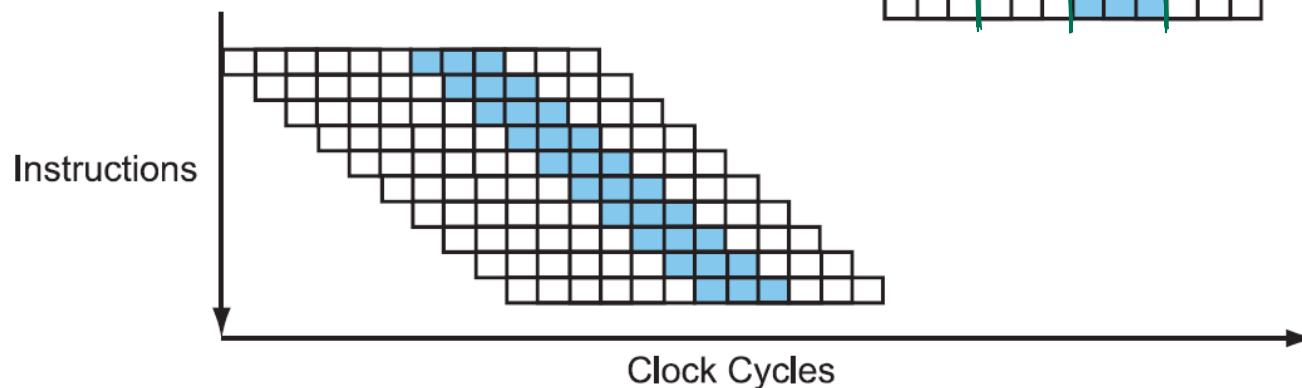
동작 대비 더 빠른 클럭 (⇨ critical path delay를 더 줄이기위해)

fetch, decode, execute, writeback 단계로 3단계화됨.

↓
subdivided

〃
high performance

- **Instruction flow of superpipelined processor**

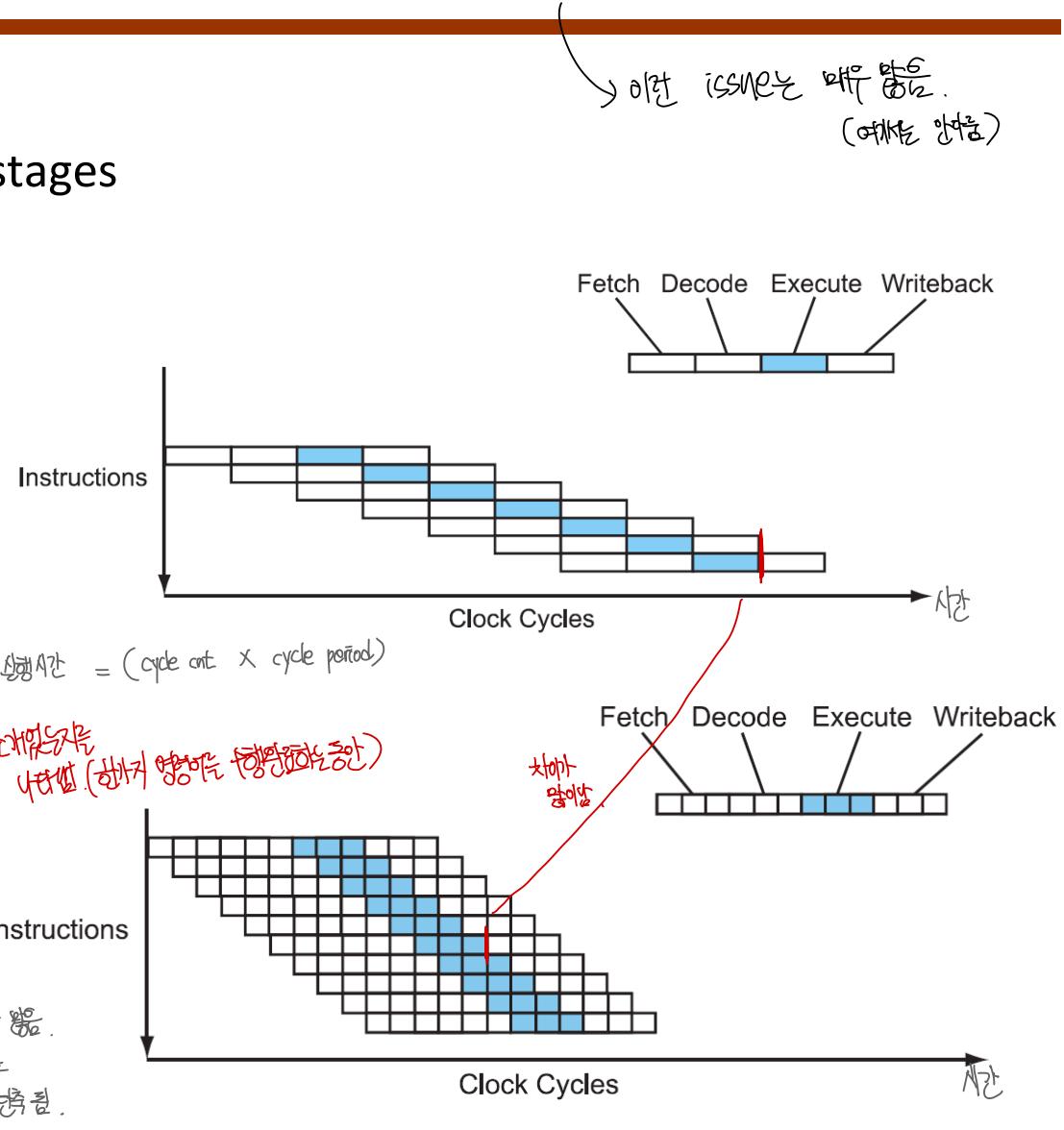
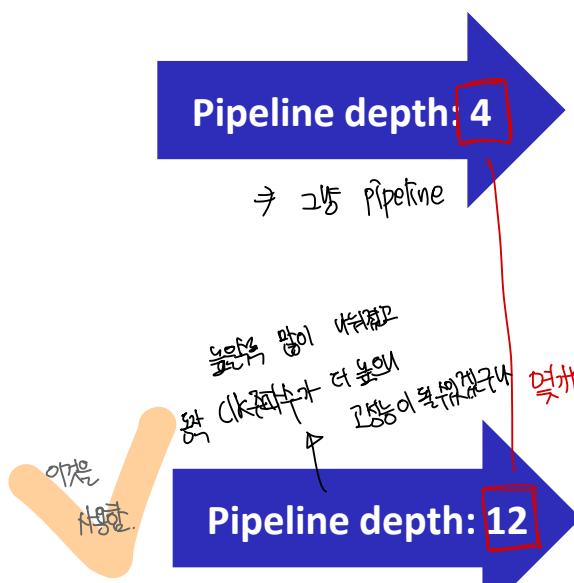


Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– What is Pipeline (Pipelining)?

- **Pipeline depth**

- Number of pipeline stages
- For example,



Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– What is Superscalar Processor?

Superscalar은 뭐인가? (scalar processor와 비슷한지 살펴보자)

Group#1										Group#2		Release		System-on-Chip					
Type	Sub Type	Product Name	Release date (Year. Month)	Fab. Tech	Power	Name	System-on-Chip						CPU						
							Micro-architecture						Spec. of Superscalar processor				Pipeline depth		
							Name	Intro. date (Year. Month)	Type	No. of Issues (Decodes)	Out of order execution	Branch prediction (speculation)	No. of Execution ports						
Embedded Computer Systems	Smart phone	iPhone 4	2010. 06	45 nm	?	Apple A4	ARM Cortex-A8	2005. ?	Super scalar	2	No	Yes	2	13	2018. ?	Super scalar	6		
		iPhone 4s	2011. 03	32 nm	?	Apple A5	ARM Cortex-A9	2007. ?	Super scalar	2	Yes	Yes	3	11	2017. 05	Super scalar	2		
		iPhone 5s	2013. 09	28 nm	2~3 W	Apple A7	Apple Cyclone	2013. ?	Super scalar	6	Yes	Yes	9	16	2019. ?	Super scalar	6		
		iPhone 6s	2015. 09	16 nm	?	Apple A9	Apple Twister	2015. ?	Super scalar	6	Yes	Yes	9	16	2017. 05	Super scalar	3		
		iPhone 7	2016. 09	16 nm	?	Apple A10 Fusion	2 x Hurricanes for high performance	2016. ?	Super scalar	6	Yes	Yes	9	16	2017. 05	Super scalar	2		
		Galaxy S8	2017. 04	10 nm	?		2 x Zephyr for energy efficiency	2016. ?	Super scalar	3	Yes	Yes	5	12	2016. 08	Super scalar	5		
		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	4 x Mongoose2 (M2) for high performance	2017. 02	Super scalar	4	Yes	Yes	8	13	2019. 05	Super scalar	5		
		iPhone XS	2018. 09	7 nm	?		4 x Cortex-A53 for energy efficiency	2012. 10	Super scalar	2	No	Yes	2	8	2015. 08	Super scalar	5		
		iPhone 11 Pro	2019. 09	7 nm	?	Apple A12	2 x Monsoon for high performance	2017. ?	Super scalar	7	Yes	Yes	13	16	2017. 10	Super scalar	5		
		Tablet PC	HP x2 210 G2 3ML39PA	2018. 02	14 nm	2W	Intel Atom® Processor x5-Z8350	2018. ?	Super scalar	3	Yes	Yes	5	12	2010. 01	Super scalar	4		
		iPhone 11 Pro	2019. 09	7 nm	?	4 x Mistral for energy efficiency	2017. ?	Super scalar	7	Yes	Yes	13	16	2013. 06	Super scalar	4			
		iPhone XS	2018. 09	7 nm	?	2 x Vortex for high performance	2018. ?	Super scalar	7	Yes	Yes	13	16	2019. ?	Super scalar	5			
		iPhone 11 Pro	2019. 09	7 nm	?	4 x Tempest for energy efficiency	2018. ?	Super scalar	3	Yes	Yes	5	12						
		Tablet PC	HP x2 210 G2 3ML39PA	2018. 02	14 nm	2W	Airmont	2015. ?	Super scalar	2	Yes	Yes	5	12-14					

Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– What is Superscalar Processor?

• Scalar processor versus Vector processor

둘의 비교해보면서 특징 알아보기

Instruction이 Data를 가지고 처리할 때
⇒ SISD, SIMD 등

Scalar Vs Vector Processing

한번에 여러 성분을
이루어진 종합체 (방향성을 가지고있음)
세부 성분을 다하고 빼기 등 연산하는 것이 원칙

Scalar Processing

각각의 명령어
개별적인 data

$$\begin{array}{rcl} a_1 & + & b_1 = c_1 \\ a_2 & - & b_2 = c_2 \\ a_3 & \times & b_3 = c_3 \\ \vdots & & \vdots \\ a_n & + & b_n = c_n \end{array}$$

Vector Processing

$$\begin{array}{ccc} a_1 & b_1 & c_1 \\ a_2 & b_2 & c_2 \\ a_3 & b_3 & c_3 \\ \vdots & \vdots & \vdots \\ a_n & b_n & c_n \end{array} =$$

명령어가 하나
(연산의 하나임)
⇒ loop문을 돌릴때 사용
(ex for)

SISD (Single Instruction Single Data)

- 각각의 명령어를 가지고 각각의 data를 처리하는 것
- 개별적인 명령을 실행하는 것

SIMD (Single Instruction Multiple Data)

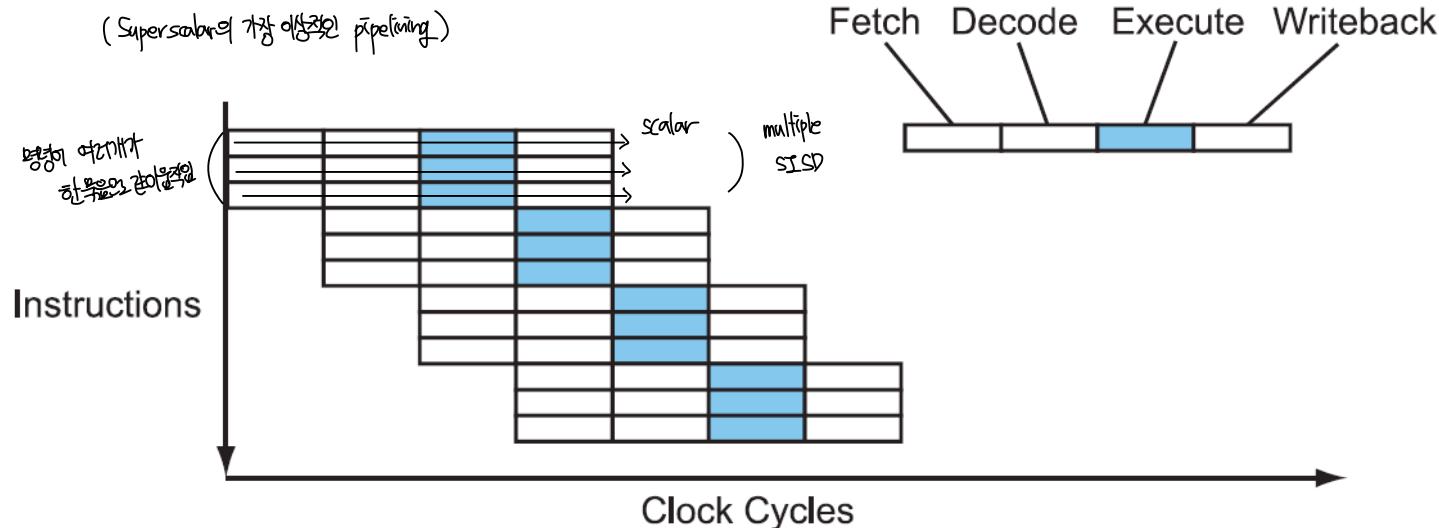
- 명령어는 하나, 데이터는 여러개

심드

Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– What is Superscalar Processor?

- **Superscalar processor** ↗ 클럭 instruction 여러개를 고침에 같다.
– Issues multiple instructions per clock cycle from a sequential stream
– Dynamic scheduling of execution units (**scheduling done in hardware**)
 ⇒ 실행 단위의 순서는 HW + scheduling 함.
– Single-core superscalar processor is classified as an SISD (Single Instruction Single Data) processor even though it performs **multiple SISDs**.
 ▪ Multi-core superscalar processor is classified as an MIMD (Multiple Instruction Multiple Data) processor.
 ⇒ multi-core 일 때만 이렇게 한다.
 한번에 여러 명령을 실행하는 경우는 실행을 허용한다.
 Runtime
 HW + scheduling
(VLIW은 예외)
 ⇒ single core superscalar는 예외
- **Instruction flow of superscalar processor**

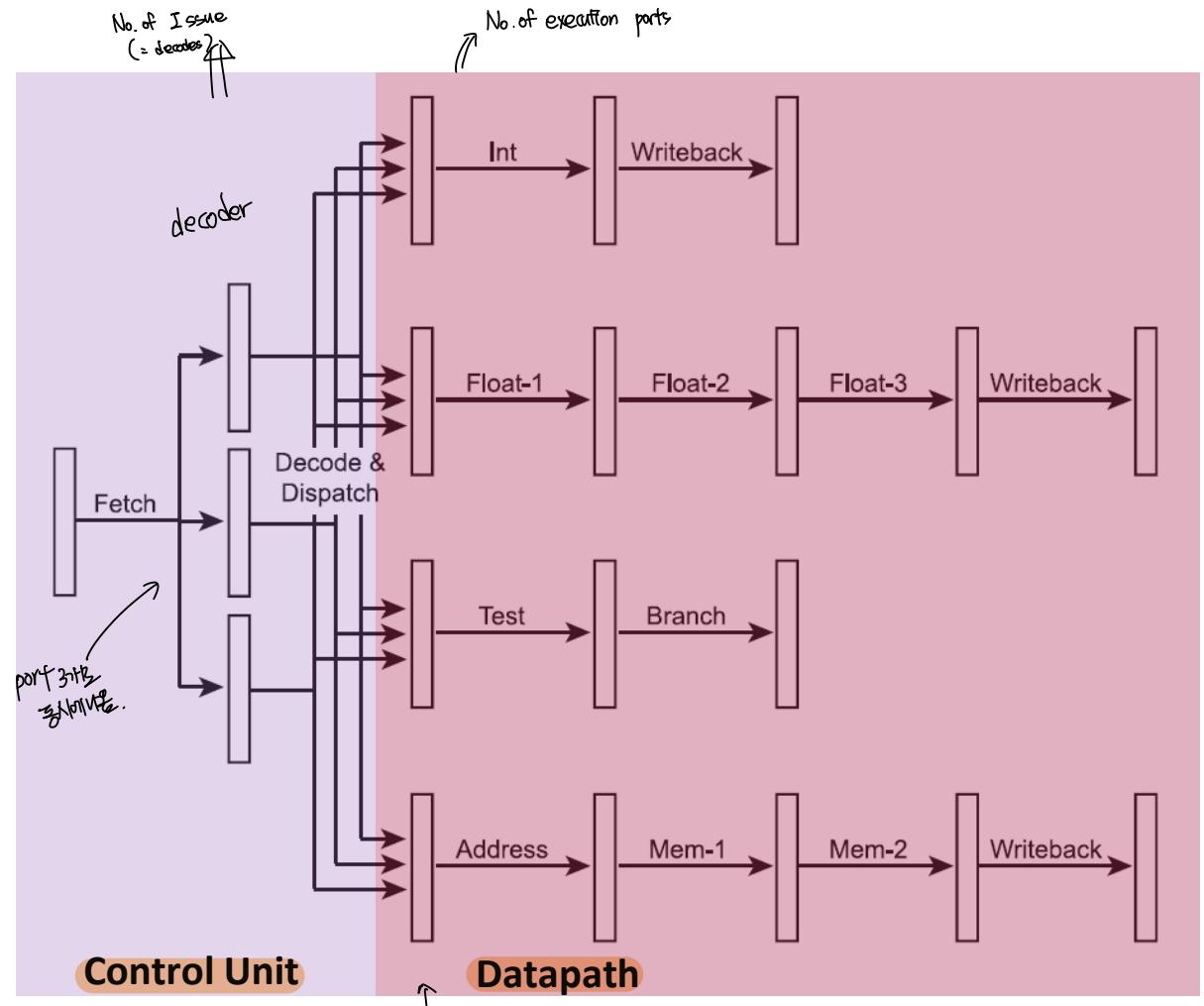
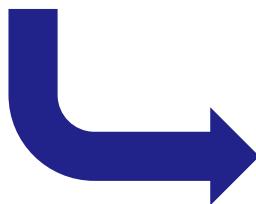
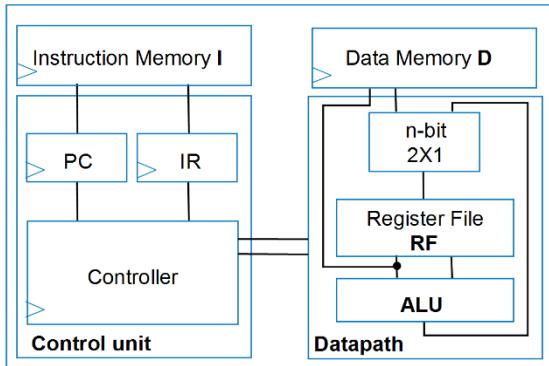


Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– What is Superscalar Processor?

- Superscalar micro-architecture

(क्रियान्वयन विशेषज्ञता architecture)

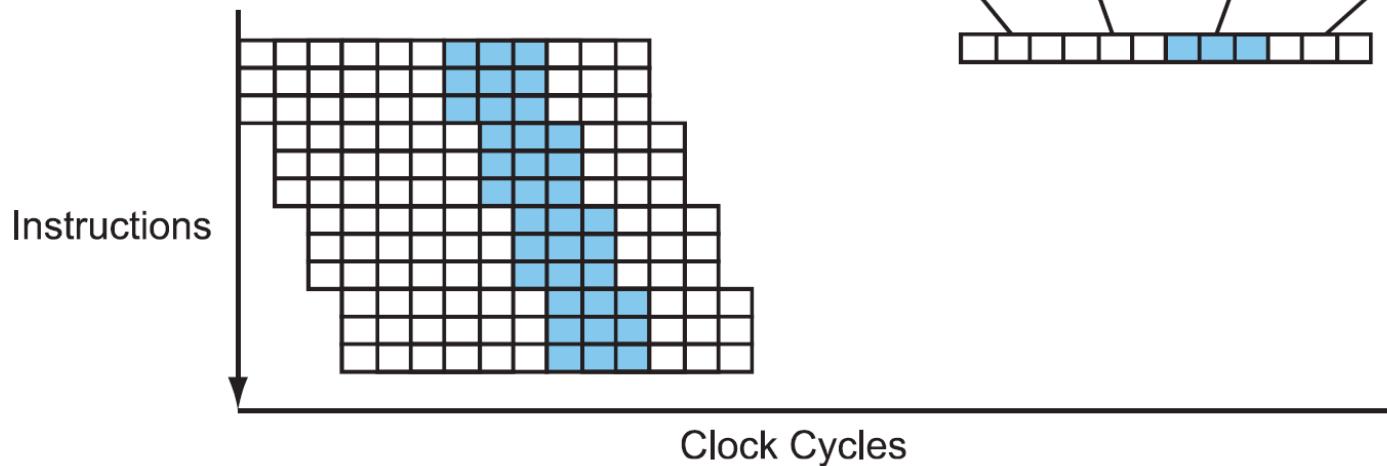


Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– What is Superscalar Processor?

- **Instruction flow of superpipelined-superscalar processor**

↳ superscalar processor이나 super pipeline이나
초기 기기들은 이 개념을 생중계함.



Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– Spec. of Superscalar Processor

- No. of Issues (decodes), No. of execution ports ?

↳ 어떤 execute를 동시에 수행할 수 있가?

적은 high performance core
+ 적은 전력

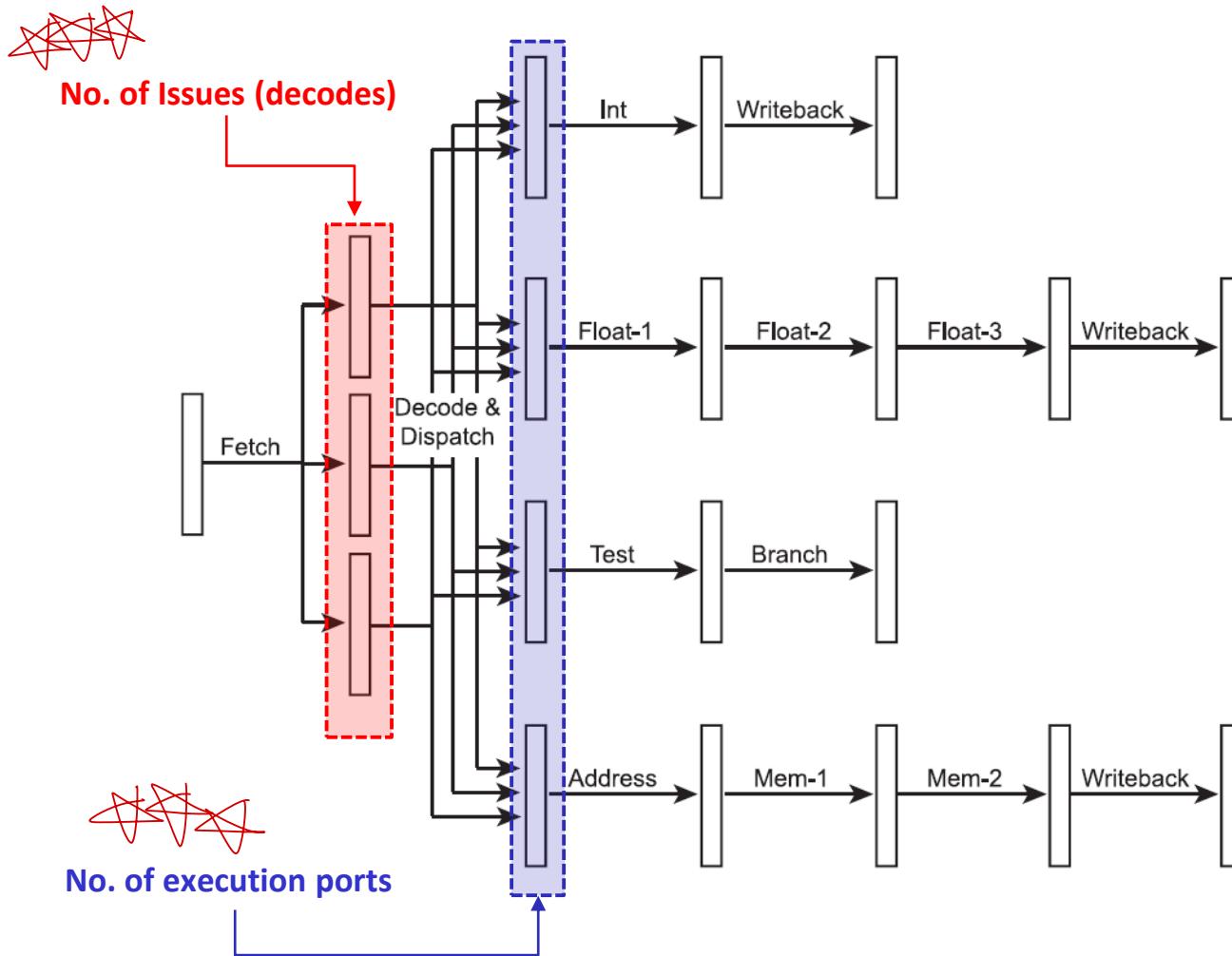
Group#1		Product Name	Release date (Year. Month)	Fab. Tech	Power	Name	System-on-Chip			CPU				Micro-architecture				Spec. of Superscalar processor			
							Type	Sub Type	Product Name	Release date (Year. Month)	Fab. Tech	Power	Name	Name	Intro' date (Year. Month)	Type	No. of Issues (Decodes)	Out of order execution	Branch prediction (speculation)	No. of Execution ports	
Group#2																					
Embedded Computer Systems	Smart phone	iPhone 4	2010. 06	45 nm	?	Apple A4	ARM Cortex-A8	2005. ?	Superscalar	2	No	Yes	2		2018. ?	Super scalar	6	Yes	Yes	12	
		iPhone 4s	2011. 03	32 nm	?	Apple A5	ARM Cortex-A9	2007. ?	Superscalar	2	Yes	Yes	3		2017. 05	Super scalar	2	No	Yes	2	
		iPhone 5s	2013. 09	28 nm	2~3 W	Apple A7	Apple Cyclone	2013. ?	Superscalar	6	Yes	Yes	9		2019. ?	Super scalar	6	Yes	Yes	12	
		iPhone 6s	2015. 09	16 nm	?	Apple A9	Apple Twister	2015. ?	Superscalar	6	Yes	Yes	9		2017. 05	Super scalar	3	Yes	Yes	8	
		iPhone 7	2016. 09	16 nm	?	Apple A10 Fusion		2 x Hurricanes for high performance	2016. ?	Superscalar	6	Yes	Yes	9		2017. 05	Super scalar	2	No	Yes	2
						2 x Zephyr for energy efficiency	2016. ?	3	Yes		Yes	5		2016. 08	Super scalar	5	Yes	Yes	8		
		Galaxy S8	2017. 04	10 nm	?	Exynos 8895		4 x Mongoose2 (M2) for high performance	2017. 02	Superscalar	4	Yes	Yes	8		2019. 05	Super scalar	5	Yes	Yes	10
						4 x Cortex-A53 for energy efficiency	2012. 10	2	No		Yes	2		2015. 08	Super scalar	5	Yes	Yes	8		
		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic		2 x Monsoon for high performance	2017. ?	Superscalar	7	Yes	Yes	13		2017. 10	Super scalar	5	Yes	Yes	8
						4 x Mistral for energy efficiency	2017. ?	3	Yes		Yes	5		2010. 01	Super scalar	4	Yes	Yes	6		
		iPhone XS	2018. 09	7 nm	?	Apple A12		2 x Vortex for high performance	2018. ?	Superscalar	7	Yes	Yes	13		2013. 06	Super scalar	4	Yes	Yes	8
						4 x Tempest for energy efficiency	2018. ?	3	Yes		Yes	5		2019. ?	Super scalar	5	Yes	Yes	8		
		iPhone 11 Pro	2019. 09	7 nm	?	Apple A13		2 x Lightning for high performance	2019. ?	Superscalar	7	Yes	Yes	13							
						4 x Thunder for energy efficiency	2019. ?	3	Yes		Yes	5									
Tablet PC	HP x2 210 G2 3ML39PA	2018. 02	14 nm	2W	Intel Atom® Processor x5-Z8350	Airmont	2015. ?	Superscalar	2	Yes	Yes	5									

2015 ~ 2019년 대비 2020년
= 7GHz freq + offload
+ core2

Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– Spec. of Superscalar Processor

- No. of Issues (decodes), No. of execution ports ? \Rightarrow 높은 처리 능력 high performance.



Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– Spec. of Superscalar Processor

- Out of order execution?

Group#1			Group#2			Release	System-on-Chip							
							System-on-Chip			CPU				
Type	Sub Type	Product Name	Release date (Year. Month)	Fab. Tech	Power	Name	Micro-architecture							
							Name	Intro' date (Year. Month)	Type	No. of Issues (Decodes)	Out of order execution	Branch prediction (speculation)	No. of Execution ports	Pipeline depth
Embedded Computer Systems	Smart phone	iPhone 4	2010. 06	45 nm	?	Apple A4	ARM Cortex-A8	2005. ?	Super scalar	2	No	Yes	2	13
		iPhone 4s	2011. 03	32 nm	?	Apple A5	ARM Cortex-A9	2007. ?	Super scalar	2	Yes	Yes	3	11
		iPhone 5s	2013. 09	28 nm	2~3 W	Apple A7	Apple Cyclone	2013. ?	Super scalar	6	Yes	Yes	9	16
		iPhone 6s	2015. 09	16 nm	?	Apple A9	Apple Twister	2015. ?	Super scalar	6	Yes	Yes	9	16
		iPhone 7	2016. 09	16 nm	?	Apple A10 Fusion	2 x Hurricanes for high performance	2016. ?	Super scalar	6	Yes	Yes	9	16
							2 x Zephyr for energy efficiency	2016. ?		3	Yes	Yes	5	12
		Galaxy S8	2017. 04	10 nm	?	Exynos 8895	4 x Mongoose2 (M2) for high performance	2017. 02	Super scalar	4	Yes	Yes	8	13
		iPhone X	2017. 11	10 nm	?		4 x Cortex-A53 for energy efficiency	2012. 10		2	No	Yes	2	8
					Apple A11 Bionic	2 x Monsoon for high performance	2017. ?	Super scalar	7	Yes	Yes	13	16	
		iPhone XS	2018. 09	7 nm		?			4 x Mistral for energy efficiency	2017. ?	3	Yes	Yes	5
					Apple A12	2 x Vortex for high performance	2018. ?	Super scalar	7	Yes	Yes	13	16	
		iPhone 11 Pro	2019. 09	7 nm		?			4 x Tempest for energy efficiency	2018. ?	3	Yes	Yes	5
					Apple A13	2 x Lightning for high performance	2019. ?	Super scalar	7	Yes	Yes	13	16	
		Tablet PC	HP x2 210 G2 3ML39PA	2018. 02	14 nm	2W	Intel Atom® Processor x5-Z8350		Airmont	2	Yes	Yes	5	12-14

Yes

No

Yes

No

Yes

Yes

Yes

No

Yes

Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– Spec. of Superscalar Processor

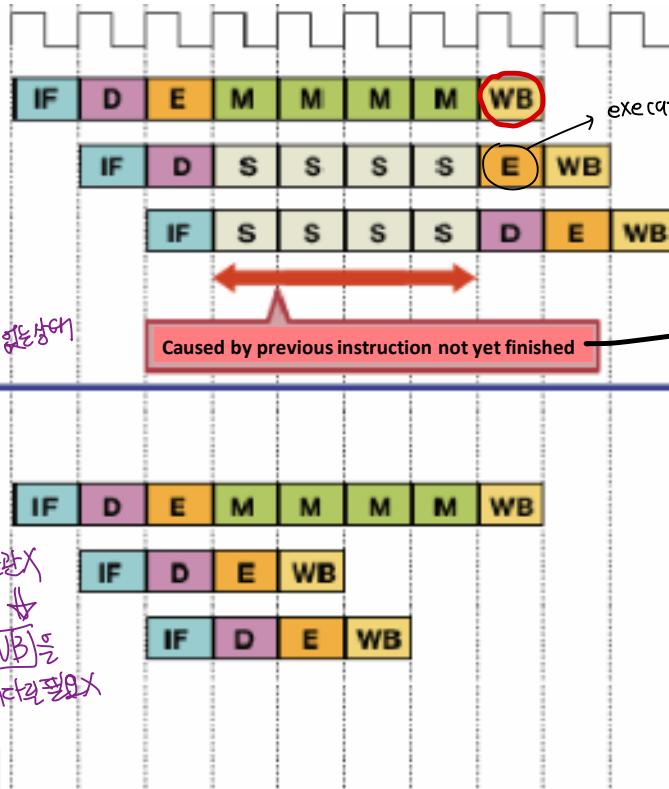
Out of order execution?

(↔ 반대 개념 In-order execution)
(순서를 맞춰서 실행)

In-Order Completion

- 1 MOV [R1], R2
- 2 ADD R4, R5
- 3 SUB R6, R7

→ 순서대로
제작설계 까지
이루어진다.



Out-of-Order Completion

- 1 MOV [R1], R2
- 2 ADD R4, R5
- 3 SUB R6, R7

→ 예상X
↓
[WB]는
차단됨X

When an instruction does not depend on subsequent instructions, there is no need to stall on the pipeline of subsequent instructions.

⊕ Single-core 기준

execution에서 Memory와 write back된 결과를
사용할 수도 있기 때문에 가능하는 것.

이걸 허지 않는다면 명령이 뒤집어
내려면 돌아가야 되는데 상황.
(pipeline 암小子로 돌아갈 경우하지 않음.)

⇒ 5 stages의 pipelining

IF : Instruction Fetch	D : Decode	E : Execution
M : Memory access	WB : Write Back	S : Stall
↓ : Execution sequence of instructions		

동작상의 문제점은 아예 없음

동작 디자인으로 해결해놓고

끌어온 것도 가능해짐

작동되는 ATS

OUT-of-order
completion
→ 가능.
↓

여전히 문제점이 있음

fetch에도 상관이 있음.

Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

→ 본기점에 대한 예측

– Spec. of Superscalar Processor

- Branch prediction (speculation)? ⇒ All "Yes" → 개별만 알기.

				Group#2		Release	System-on-Chip							CPU			Micro-architecture				
							System-on-Chip			CPU				Micro-architecture			Spec. of Superscalar processor				
Type	Sub Type	Product Name	Release date (Year. Month)	Fab. Tech	Power	Name	Name	Intro' date (Year. Month)	Type	No. of Issues (Decodes)	Out of order execution	Branch prediction (speculation)	No. of execution ports	Pipeline depth	Out of order execution	Branch prediction (speculation)	No. of execution ports				
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		iPhone 4s	2011. 03	32 nm	?	Apple A5	ARM Cortex-A9	2007. ?	Superscalar	2	Yes	Yes	3	11	No	Yes	3	11	Yes	Yes	
		iPhone 5s	2013. 09	28 nm	2~3 W	Apple A7	Apple Cyclone	2013. ?	Superscalar	6	Yes	Yes	9	16	Yes	Yes	9	16	Yes	Yes	
		iPhone 6s	2015. 09	16 nm	?	Apple A9	Apple Twister	2015. ?	Superscalar	6	Yes	Yes	9	16	No	Yes	9	16	Yes	Yes	
		iPhone 7	2016. 09	16 nm	?	Apple A10 Fusion	2 x Hurricanes for high performance	2016. ?	Superscalar	6	Yes	Yes	9	16	Yes	Yes	9	16	Yes	Yes	
							2 x Zephyr for energy efficiency	2016. ?		3	Yes	Yes	5	12	No	Yes	5	12	Yes	Yes	
		Galaxy S8	2017. 04	10 nm	?	Exynos 8895	4 x Mongoose2 (M2) for high performance	2017. 02	Superscalar	4	Yes	Yes	8	13	Yes	Yes	8	13	Yes	Yes	
		4 x Cortex-A53 for energy efficiency	2012. 10	2	No		Yes	2		8	No	Yes	2	8	Yes	Yes					
		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	2 x Monsoon for high performance	2017. ?	Superscalar	7	Yes	Yes	13	16	Yes	Yes	13	16	Yes	Yes	
		4 x Mistral for energy efficiency	2017. ?	3	Yes		Yes	5		12	No	Yes	5	12	Yes	Yes					
		iPhone XS	2018. 09	7 nm	?	Apple A12	2 x Vortex for high performance	2018. ?	Superscalar	7	Yes	Yes	13	16	Yes	Yes	13	16	Yes	Yes	
		4 x Tempest for energy efficiency	2018. ?	3	Yes		Yes	5		12	No	Yes	5	12	Yes	Yes					
		iPhone 11 Pro	2019. 09	7 nm	?	Apple A13	2 x Lightning for high performance	2019. ?	Superscalar	7	Yes	Yes	13	16	Yes	Yes	13	16	Yes	Yes	
		4 x Thunder for energy efficiency	2019. ?	3	Yes		Yes	5		12	No	Yes	5	12	Yes	Yes					
Tablet PC	HP x2 210 G2 3ML39PA	2018. 02	14 nm	2W	Intel Atom® Processor x5-Z8350	Airmont	2015. ?	Superscalar	2	Yes	Yes	5	12-14	Yes	Yes	5	12-14	Yes	Yes	Yes	Yes

Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

– Spec. of Superscalar Processor

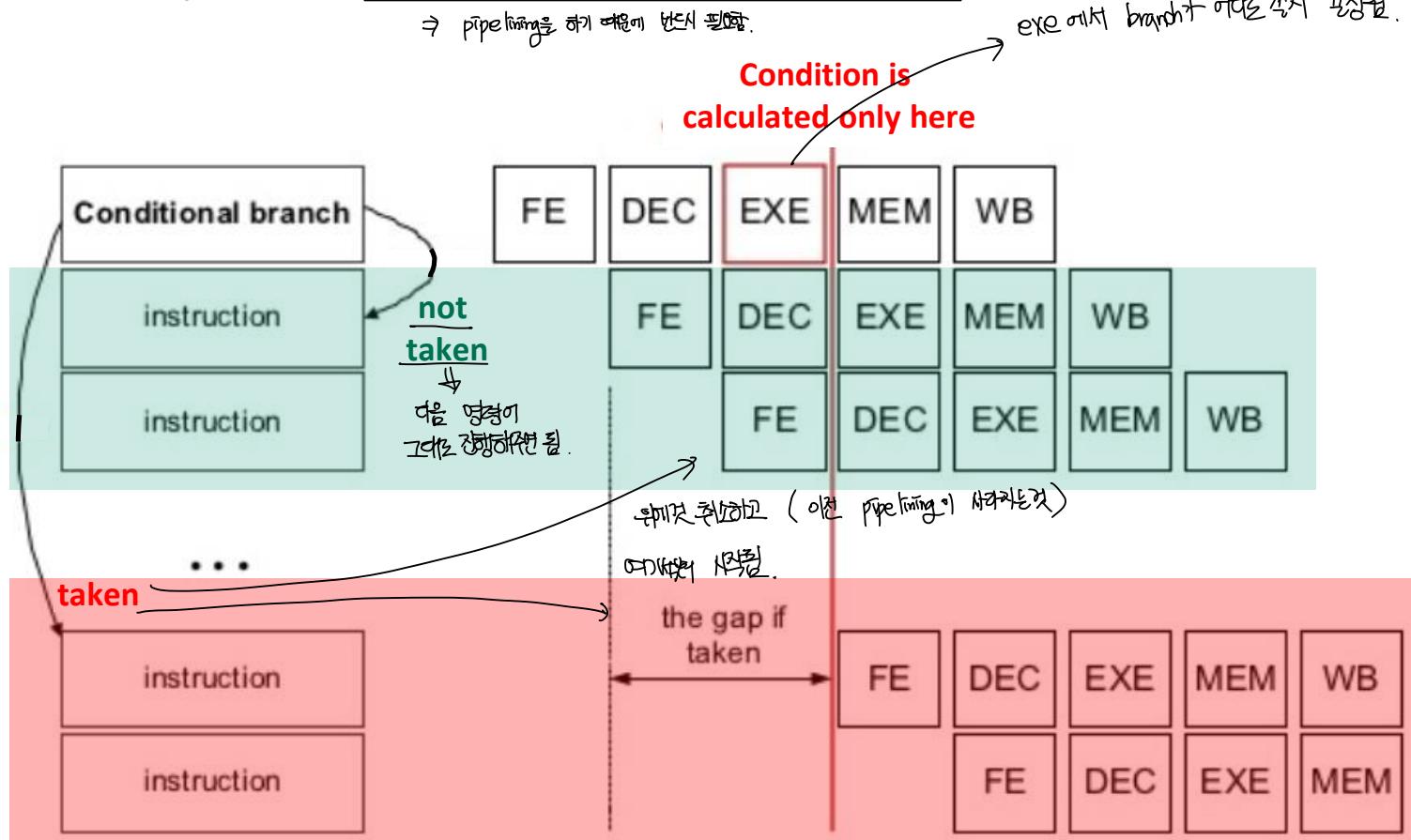
- Branch prediction (speculation)? ⇒ Branch 예측이 왜 필요한가?

- Why need?: in order not to stall pipelining

⇒ pipelining을 하기 때문에 반드시 필요함.

exe에서 branch' 여부를 먼저 결정됨.

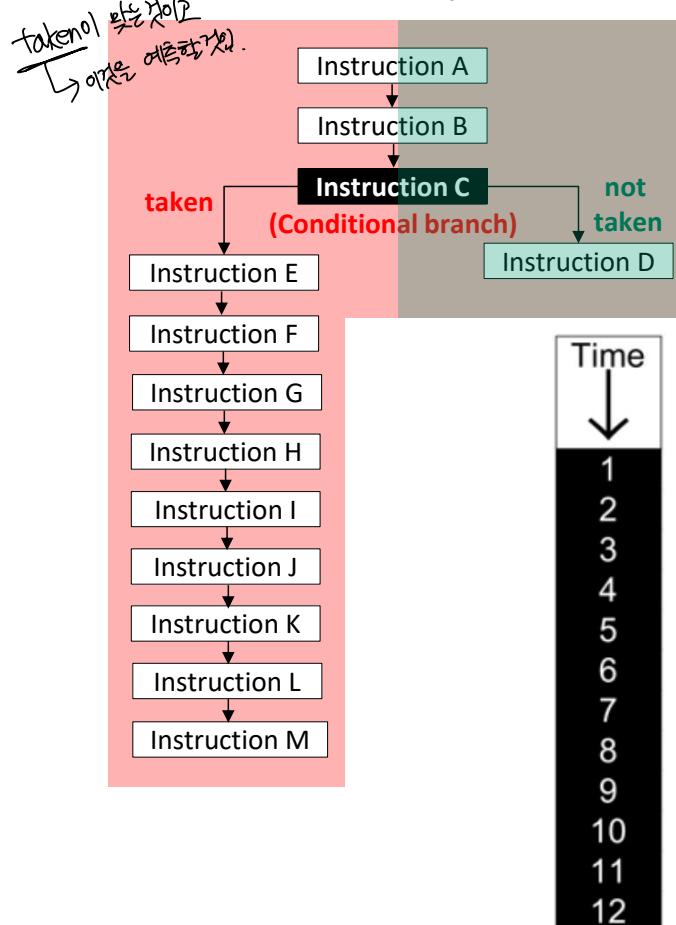
Condition is
calculated only here



Key Factors for Analyzing Micro-Architecture of Commercial CPU Products

- Branch prediction (speculation)?

– For example



둘째에는 기본이상함
(이미 타 개별화된 틀에 간 기술)

SW₃
이것은 예측하는
한국어의 일부

1

pipeline ٿوں چھو

pipeline 안하는 경우

stall C
(not taken)

Stall X
(taken)

경우

pipeline 안 하는 경우

'taken' selected
in instruction C

pipeline 하는 경

**'taken' selected
in instruction C**

성(성) 예측
(는) predicted + 끝이야함)

**predicted with
‘taken’**

Conventional			#
Fetch	Decode	Process	
A			0
	A		0
B		A	1
	B		1
C		B	1
	C		2
E		C	2
	E		3
E		E	3

Pipelined			
Fetch	Decode	Process	#
A	*	*	0
B	A	*	0
C	B	A	1
	C	B	2
		C	3
E	E		3
F		E	4
G	F	E	5
H	G	F	6
I	H	G	7
J	I	H	8
K	J	I	

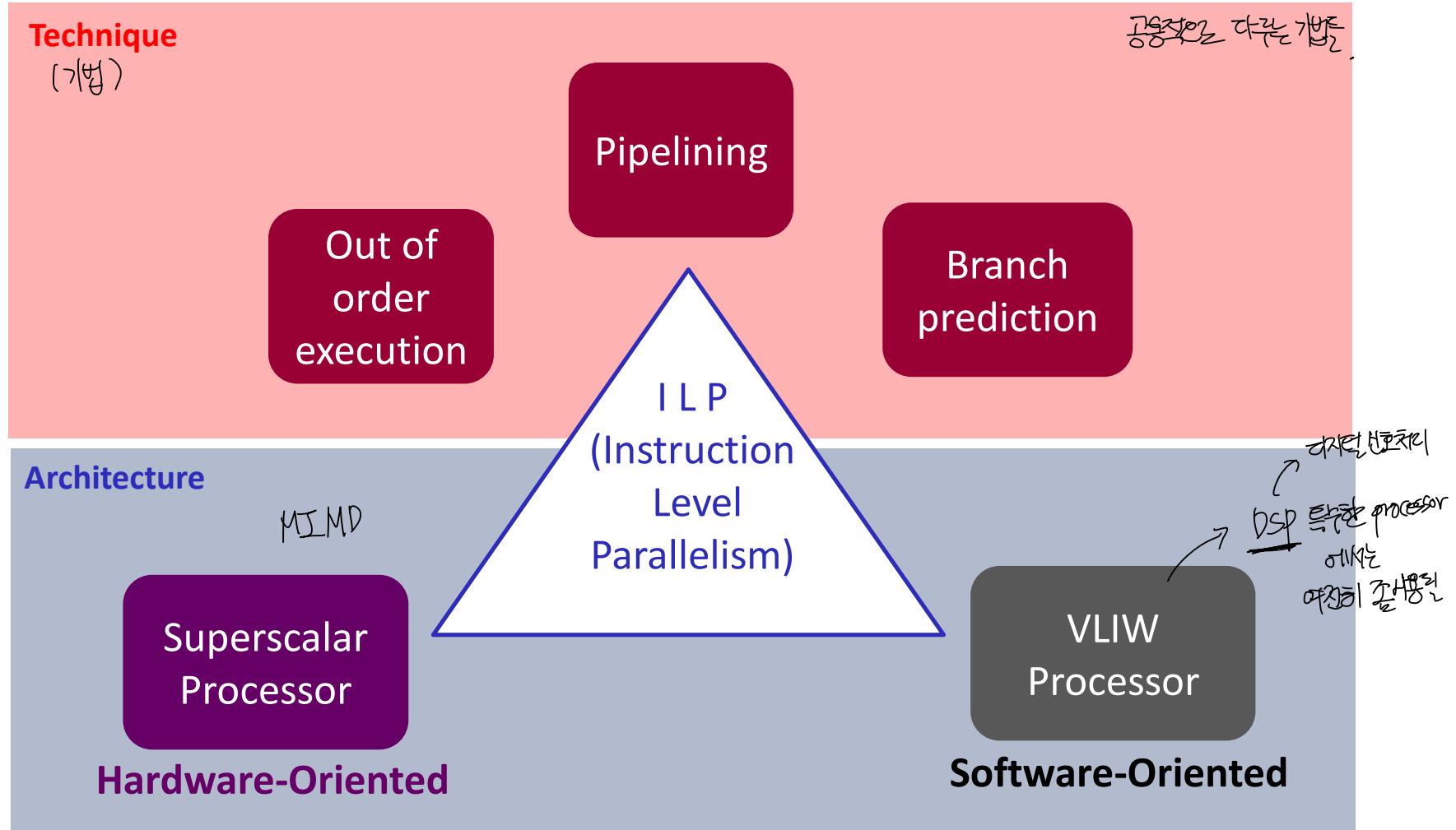
Pipelined with branch prediction			
Fetch	Decode	Process	#
A	*	*	0
B	A	*	0
C	B	A	(1)
E	C	B	(2)
F	E	C	(3)
G	F	E	(4)
H	G	F	(5)
I	H	G	(6)
J	I	H	(7)
K	J	I	(8)
L	K	J	(9)
M	L	K	(10)

Infraktionen

최대한 많은 명령을 병렬로 동시에 다발적으로 처리하면 성능이 향상됨.

Introduction to ILP (Instruction Level Parallelism)

Multi-core \Rightarrow TLP (Threads Level Parallelism) \rightarrow 공정기능의 발달로 개발됨 ...



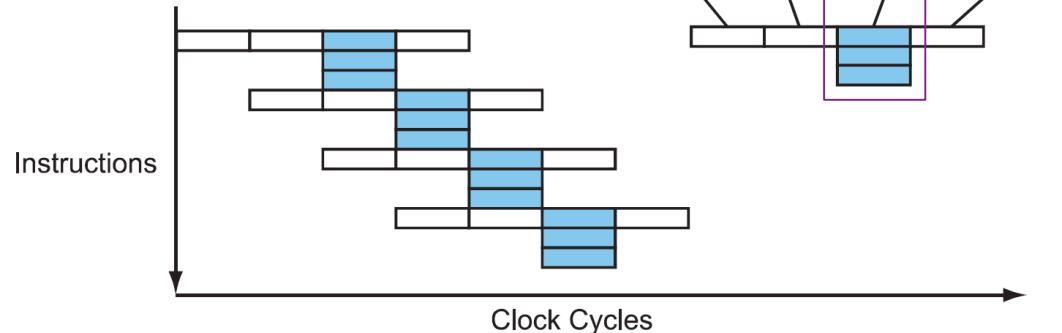
What is VLIW (Very Long Instruction Word) Processor?

복잡한 명령어

- **VLIW (Very Long Instruction Word) processor**

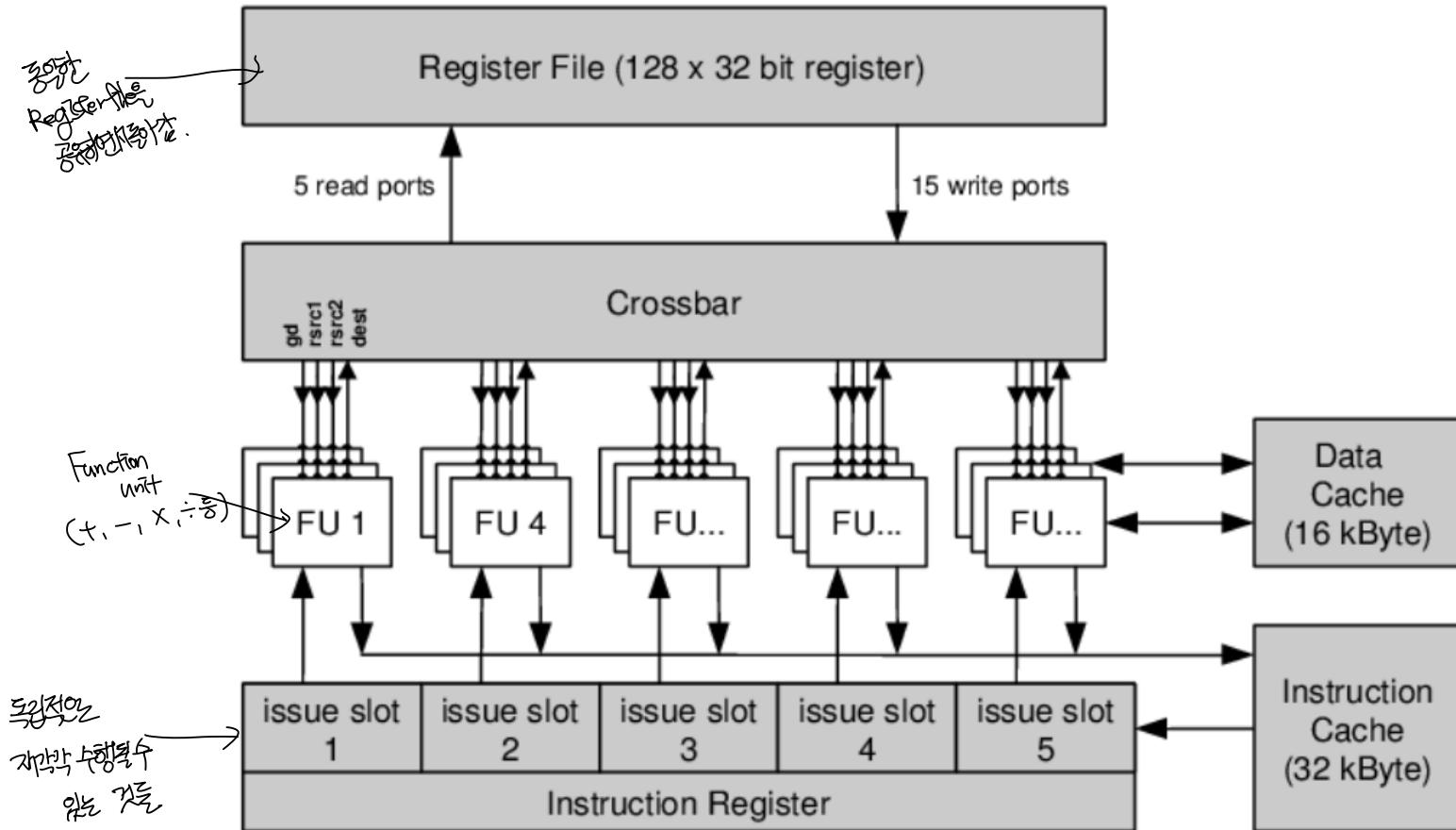
- Issues one very ‘wide’ instruction per clock cycle; this instruction contains multiple operations
 - If the multiple operations in an instruction are different.
→ scheduling 은 compiler가 함. (또 다른 실행 단계에 병행)
- Static scheduling of execution units (**done by compiler**).
- Single-core VLIW processor may be classified as a **SISD** (Single Instruction Single Data) processor.
 - If the multiple operations in an instruction are same.
→ 명령어가 다 다른 경우
(+, -, X, ÷ 등)
- Single-core VLIW processor may be classified as a **SIMD** (Single Instruction Multiple Data) processor.
 - If the multiple operations in an instruction are same.
→ 명령어가 다 같은 경우
(또 X 이다 등)
→ 동일한 수행 단계로 병행할 명령어가
같이 들어가 있는 것.
↓
포장한 개의 명령어.

- **Instruction flow of VLIW processor**



What is VLIW (Very Long Instruction Word) Processor?

- **VLIW micro-architecture** (어려운 VLIW 설계)



Comparison between superscalar processor and VLIW processor

Win

Superscalar Processor

- **Hardware finds parallelism**
↳ 주제가 HW, HW가 병렬성을 발견함.
- **More complex hardware**
↳ 복잡한 HW
- **More power consumption**
↳ power 소모得多
- **Works even with lousy compiler**
↳ compiler가 안좋아도
작동작함.

power를 발견하는.
(in Runtime)

VS

VLIW Processor

- **Compiler finds parallelism**
↳ 컴파일러가 프로그램 실행전에 병렬성을 찾아놓음.
- **Simpler hardware**
↳ 단순한 HW
- **Less power consumption**
↳ power 소모 적다
- **Works only if compiler has done the right things**
↳ 아주 좋은 compiler가 필요함.
↳ 브제이는 predict한 것이 바운드를 넘는다.

lose

→ 공정기술이 발전하면서 복잡한 HW가 큰 문제로
아니게 됨.

설계상에 한계가 있다.

Comparison between superscalar processor and VLIW processor

- Why have the superscalar processor become the norm in today's commercial CPUs, not VLIW processor?

↳ 왜 Superscalar 가 오늘날 상용 CPU에 널리 표준화되었는가?

- <https://namu.wiki/w/%EC%9D%B8%ED%85%94%20%EC%95%84%EC%9D%B4%ED%83%9C%EB%8B%88%EC%97%84%20%EC%8B%9C%EB%A6%AC%EC%A6%88>

↳ “인텔 아이언ium 시리즈”
(ITANIUM)

↳ “VLIW” architecture 을 선택한 core 업체
↳ x86을 바탕으로 새로운 core를 만들고
↳ 완전방향...

↳ 사용자(?) 풍자

AMD(1991) 블루스톤
(2001년 → 2005년)
1991 ~ 2000년경

AMD Intel
↳ 빠른 계산
(instruction 단위)

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

기준
Guideline

Prerequisite = 선제제한

Techniques for Improving Performance	Synergy Effect (① and ②)		Synergy Effect (③ and ④)		⑤ Increase of Clock Frequency
	① Improvement of Micro-Architecture	② Increase of Private Cache Size	③ Increase in the Number of Cores	④ Increase of Shared Cache Size	
Problems	Increasing Power Consumption	Increasing Much Power Consumption	Increasing Power Consumption	Increasing Much Power Consumption	Increasing Power Consumption
	power 증가	power 증가	① < ③ power	power 증가	power 증가
Improvement of Fabrication process Technology (For example: 14nm process → 10nm process)					
Relieving/Reducing the problems	Effect	Reduction of Delay and Power Consumption in CMOS			

문제를 완화 / 경감 시켜줄 수 있음.

→ 공정기술의 발전 영향

특히 암체이드에 영향이 큼

① ② ⑤ ⇒ 갈이하기

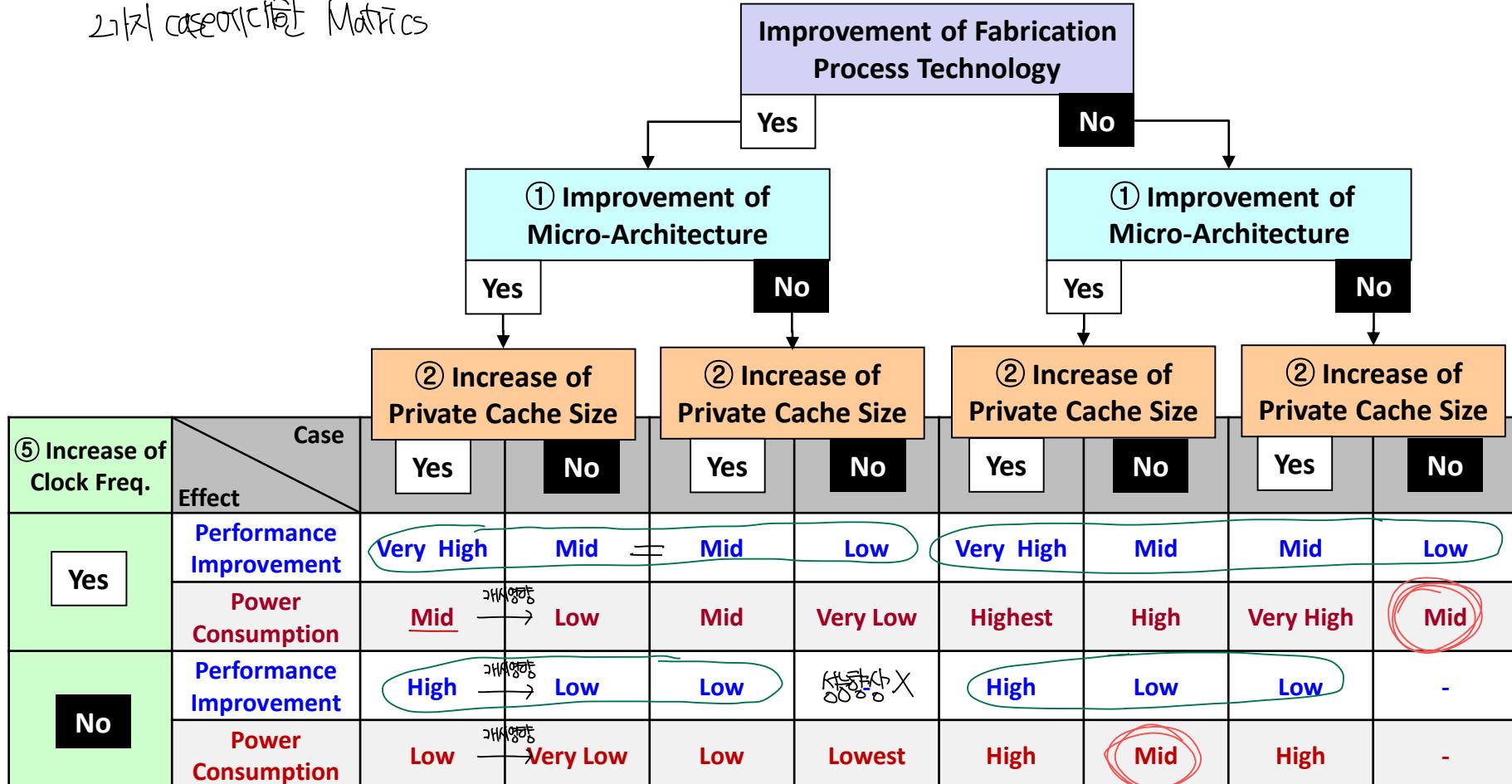
③ ④ ⑤ ⇒ 갈이하기

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

* 종합화재에서 많은 종류 architecture

- Metrics for embedded CPU and non-embedded CPU in laptop (general PC)

2 가지 case에 대한 Metrics

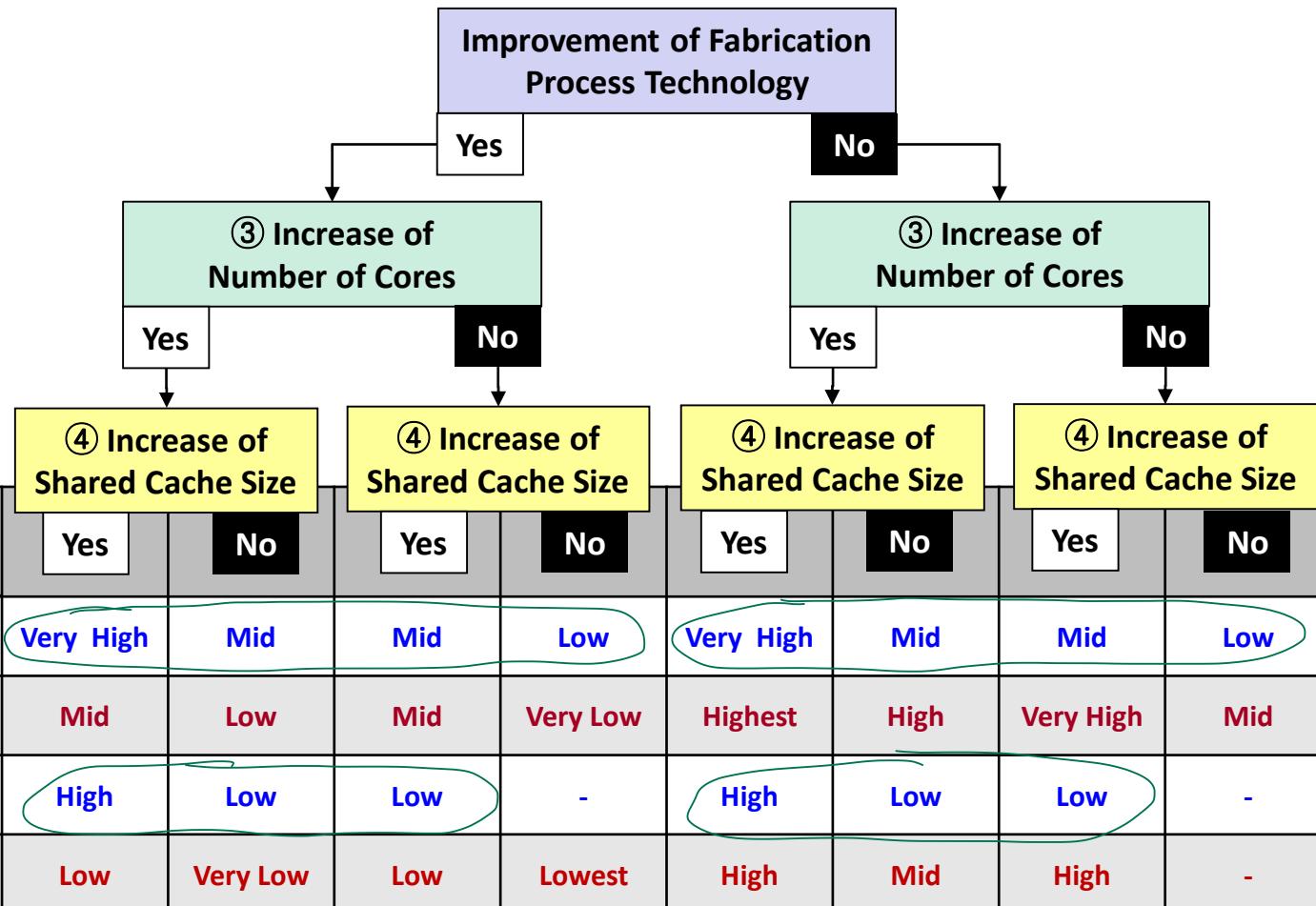


→ 공정이 적용되지 않음

(Faster), but power efficient

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

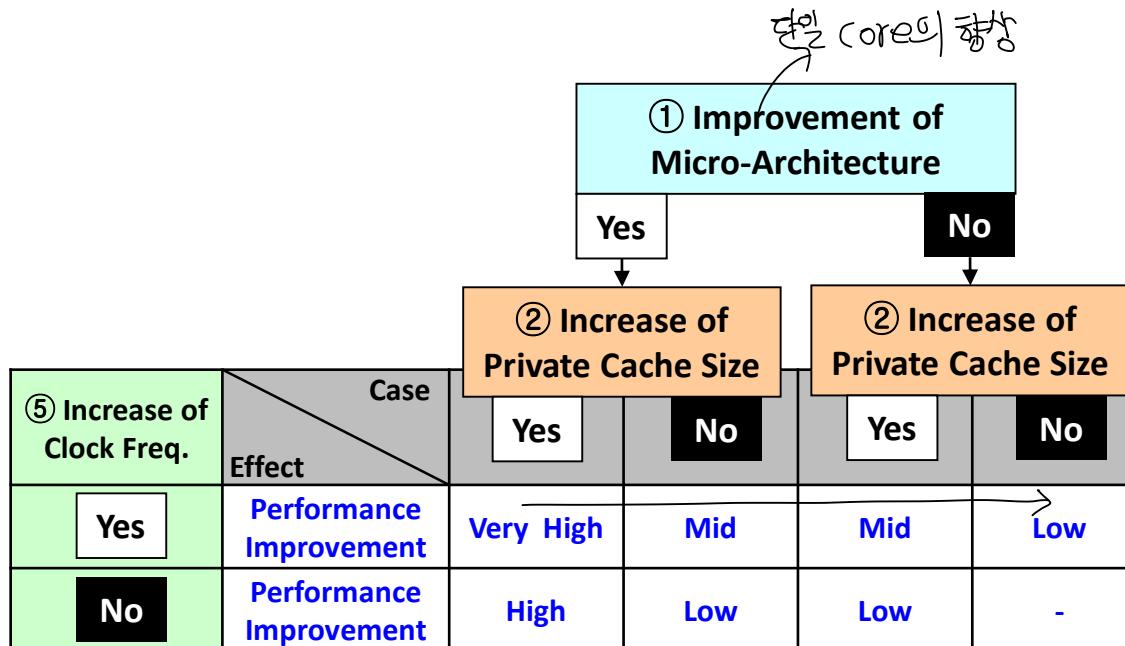
- Metrics for embedded CPU and non-embedded CPU in laptop (general PC)



Performance-Power Consumption Metrics for Evaluating Commercial CPUs

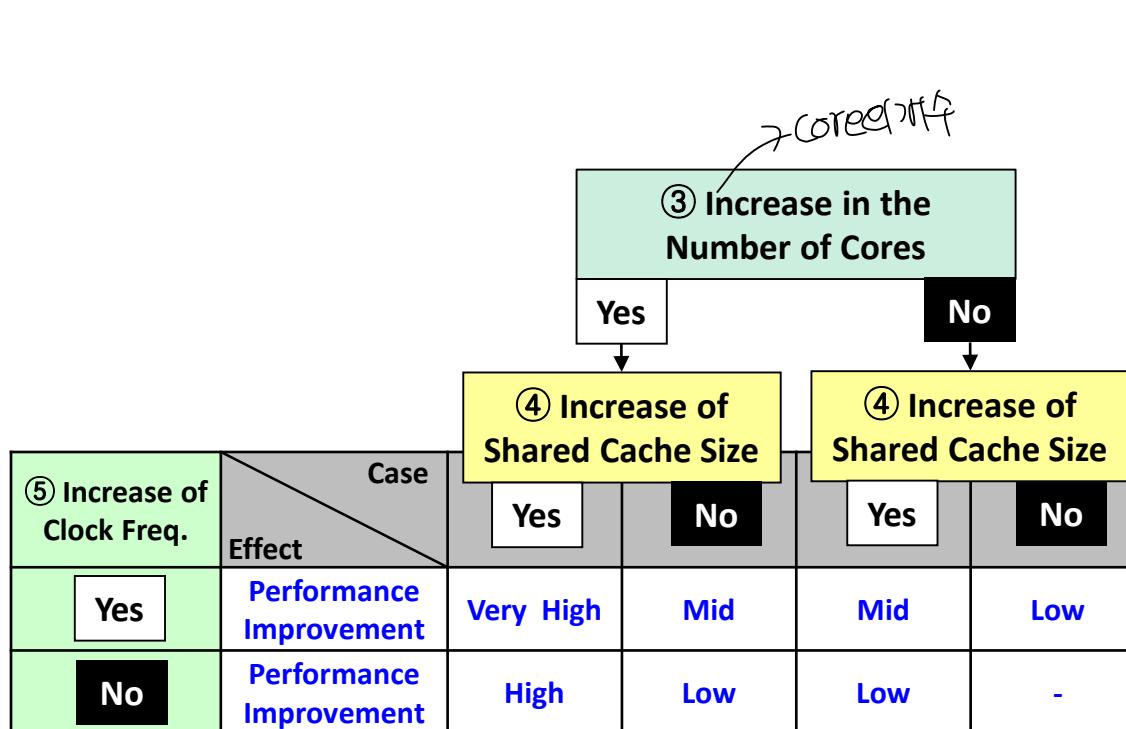
- Metrics for non-Embedded CPU in desktop, server and workstation

↳ 이 종류 구조하기



Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Metrics for non-Embedded CPU in desktop, server and workstation



Core당 힘
1 코어당 힘
3 코어당 힘
4 코어당 힘 .

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#1 (laptop)

Group#2

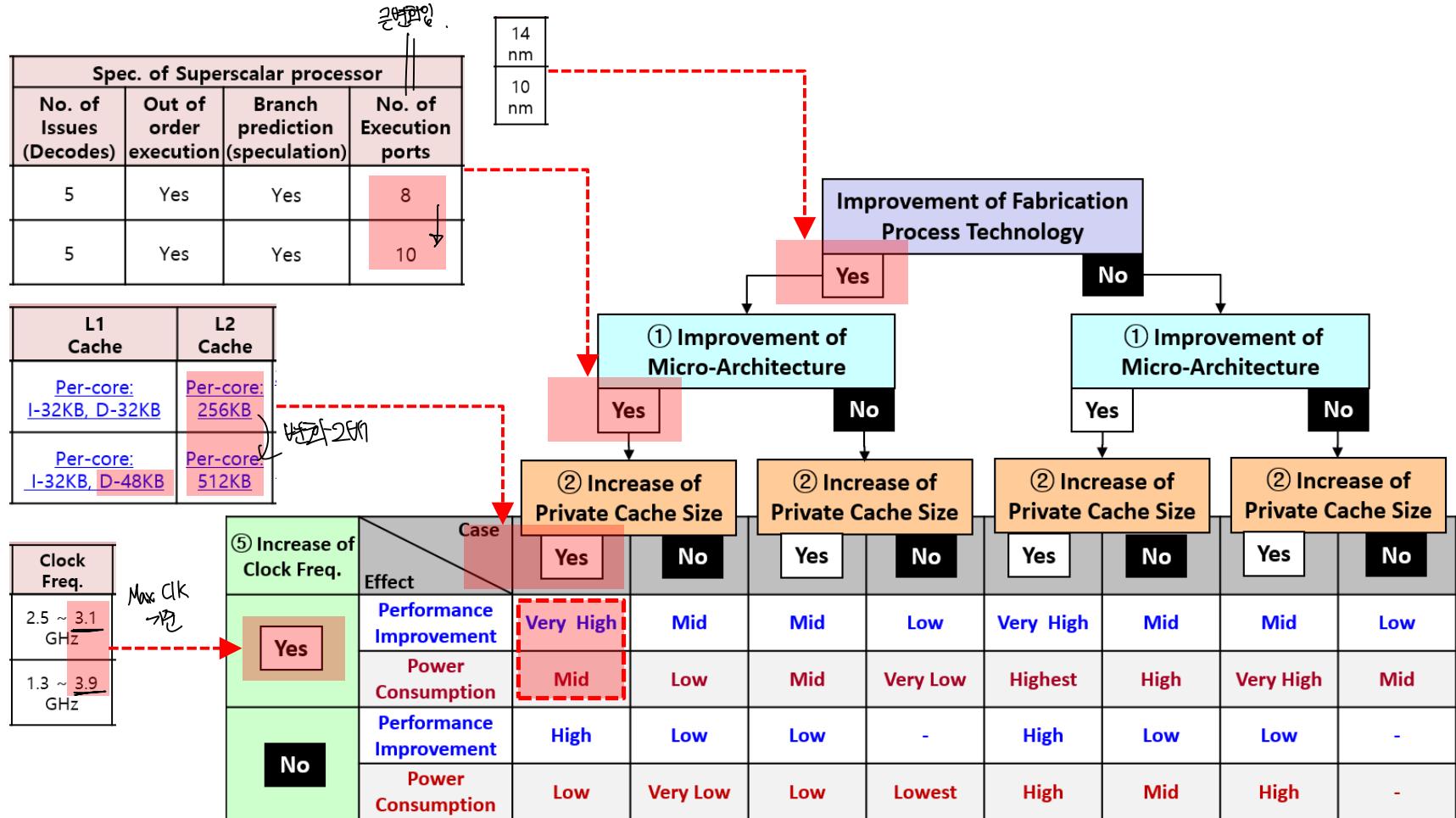
Type	Sub Type	Product Name	Release date (Year. Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators										
				Fab. Tech	Power	Name	CPU							Cache
							Micro-architecture	Bit-Width	Clock Freq.	ISA	No. of Cores	L1 Cache	L2 Cache	
General PC	Laptop	SAMSUNG NT900X3N-K59SS	2015. 03	14 nm	15W	Intel® Core™ i5-7200U	7th Gen. Kaby Lake	64	2.5 ~ 3.1 GHz	x86 -64	2	Per-core: I-32KB, D-32KB	Per-core: 256KB	3MB shared by 2 cores and GPU
		LG GRAM 17ZD90N-VX70K	2019. 12	10 nm	15W	Intel® Core™ i7-1065G7	10th Gen. Ice Lake	64	1.3 ~ 3.9 GHz	x86 -64	4	Per-core: I-32KB, D-48KB	Per-core: 512KB	8MB shared by 4 cores and GPU

Group#2

Type	Sub Type	Product Name	Release date (Year. Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators										Pipeline depth	
				Fab. Tech	Power	Name	CPU								
							Name	Intro' date (Year. Month)	Type	Spec. of Superscalar processor					
General PC	Laptop	SAMSUNG NT900X3N-K59SS	2017. 07	14 nm	15W	Intel® Core™ i5-7200U	7th Gen. Kaby Lake	2016. 08	Super scalar	5	Yes	Yes	8	14-19	
		LG GRAM 17ZD90N-VX70K	2019. 12	10 nm	15W	Intel® Core™ i7-1065G7	10th Gen. Ice Lake	2019. 05	Super scalar	5	Yes	Yes	10	14-19	

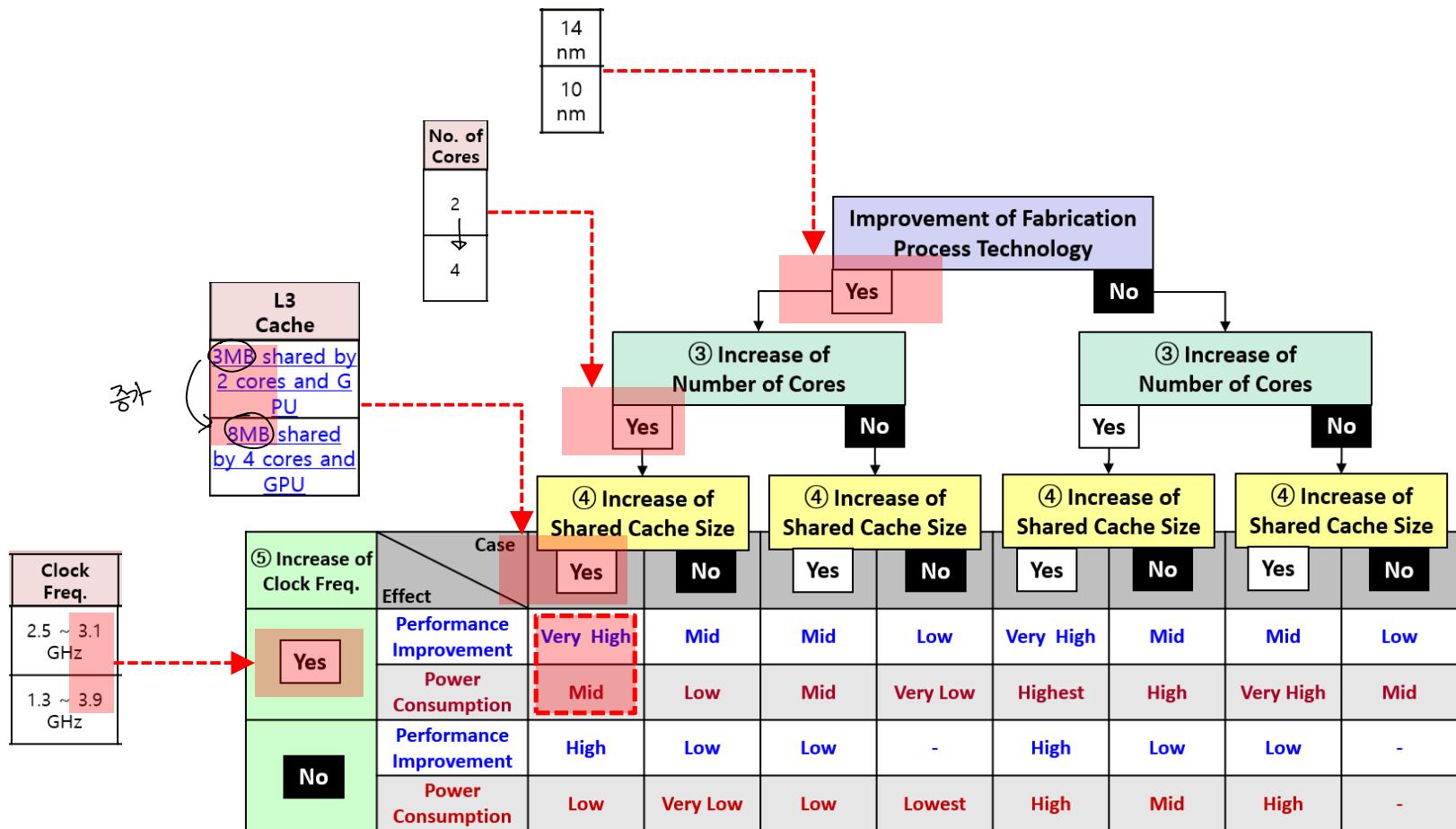
Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#1 (laptop)



Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#1 (laptop)



Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#2-1 (smartphone-Galaxy)

Group#1 & 2

High performance core 한 베이스인 것임.

Type	Sub Type	Product Name	Release date (Year, Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators										
				Fab. Tech	Power	Name	CPU							L3 Cache
							Micro-architecture	Bit-Width	Clock Freq.	ISA	No. of Cores	L1 Cache	L2 Cache	
Embedded Computer Systems	Smart Phone	Galaxy S8	2017. 04	10 nm	?	Exynos 8895	4 x Mongoose2 (M2) for high performance	64	2.3 GHz	ARM v8-A	8	Per-core: I-64KB, D-32KB	2MB shared	None
							4 x Cortex-A53 for energy efficiency	32	1.7 GHz		11	Per-core: I-32KB, D-32KB	256KB shared	
Embedded Computer Systems	Smart Phone	Galaxy S9	2018. 03	10 nm	?	Exynos 9810	4 x Meerkat (M3) for high performance	64	2.9 GHz	ARM v8-A	8	Per-core: I-64KB, D-64KB	Per-core: 512KB	4MB shared
							4 x Cortex-A55 for energy efficiency	32	1.9 GHz	ARM v8.2-A	8	Per-core: I-32KB, D-32KB	256KB Shared	

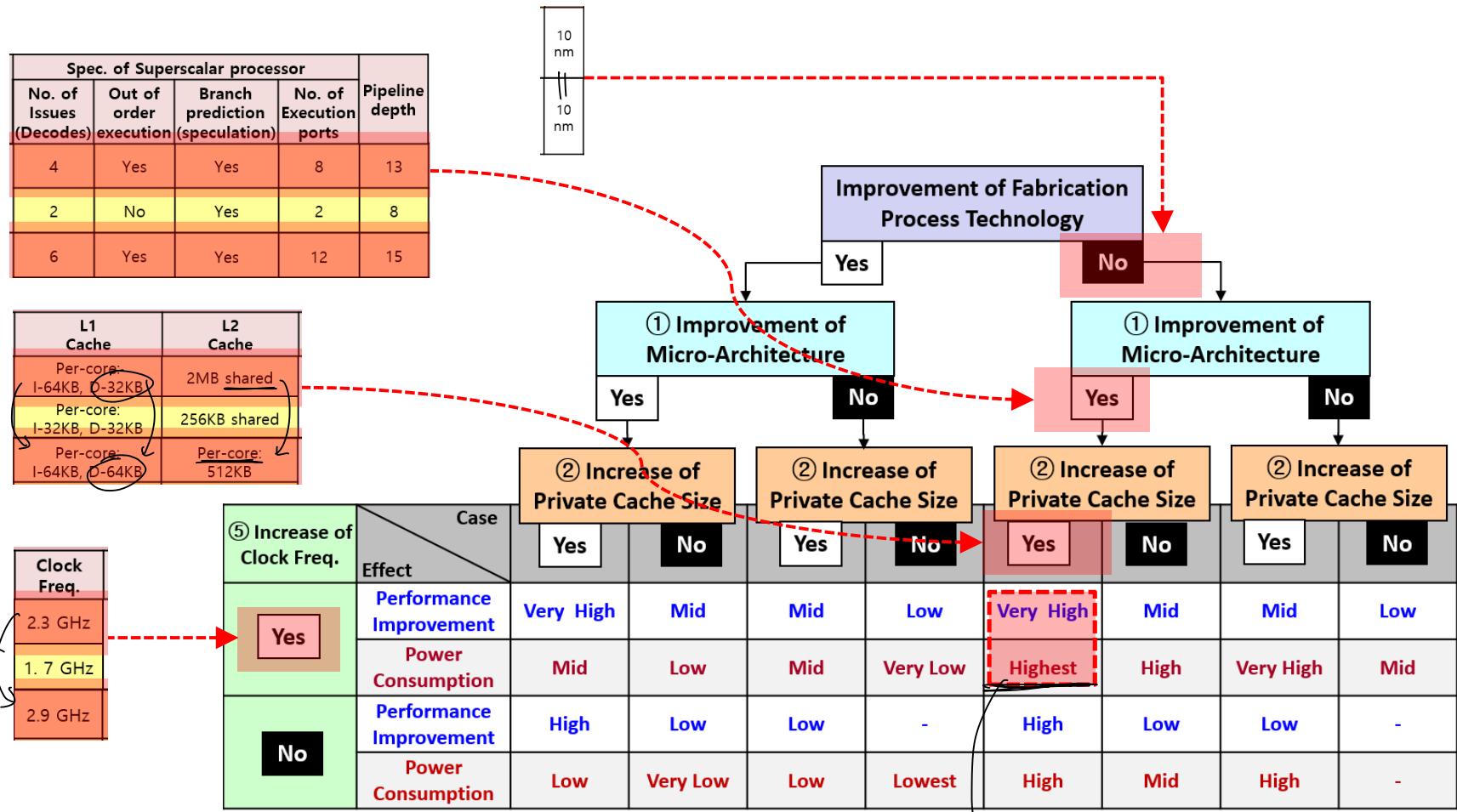
자체
제작

자체 제작된 Micro-architecture입니다.

Type	Sub Type	Product Name	Release date (Year, Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators										
				Fab. Tech	Power	Name	CPU							Pipeline depth
							Name	Intro' date (Year, Month)	Type	Spec. of Superscalar processor				
Embedded Computer Systems	Smart Phone	Galaxy S8	2017. 04	10 nm	?	Exynos 8895	4 x Mongoose2 (M2) for high performance	2017. 02	Super scalar	4	Yes	Yes	8	13
							4 x Cortex-A53 for energy efficiency	2012. 10	Super scalar	2	No	Yes	2	8
Embedded Computer Systems	Smart Phone	Galaxy S9	2018. 03	10 nm	?	Exynos 9810	4 x Meerkat (M3) for high performance	2018. ?	Super scalar	6	Yes	Yes	12	15
							4 x Cortex-A55 for energy efficiency	2017. 05	Super scalar	2	No	Yes	2	8

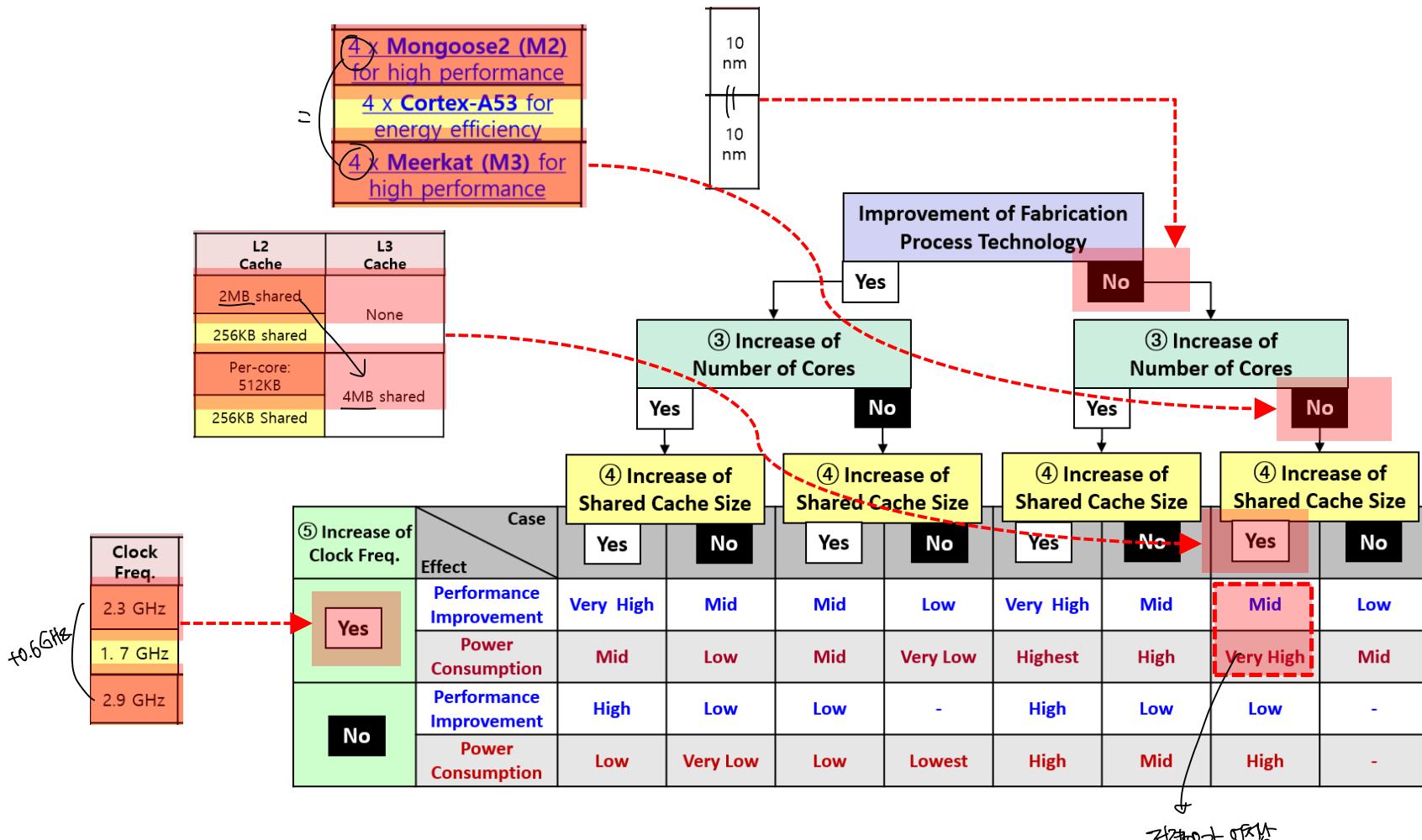
Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#2-1 (smartphone-Galaxy)



Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- **Commercial CPU evaluation** : Example#2-1 (smartphone-Galaxy)



Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#2-2 (smartphone-Galaxy)

Group#2

Type	Sub Type	Product Name	Release date (Year. Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators								
				Fab. Tech	Power	Name	CPU					③ No. of Cores
							Micro-architecture	Bit-Width	⑤ Clock Freq.	ISA		
Embedded Computer Systems	Smart Phone	Galaxy S9	2018. 03	10 nm	?	Exynos 9810	4 x Meerkat (M3) for high performance	64	2.9 GHz	ARM v8-A	8	Per-core: I-64KB, D-64KB
			2019. 08	7 nm	?		4 x Cortex-A55 for energy efficiency	64	1. 9 GHz	ARM v8.2-A	8	Per-core: I-32KB, D-32KB Shared
		Galaxy Note10	2019. 08	7 nm	?	Exynos 9825	2 x Cheetah (M4) for high performance	64	2.73 GHz	ARM v8.2-A	8	Per-core: I-64KB, D-64KB
			2019. 08	7 nm	?		2 x Cortex-A75 for moderate performance	64	2.4 GHz	ARM v8.2-A	8	Per-core: I-64KB, D-64KB
			2019. 08	7 nm	?		4 x Cortex-A55 for energy efficiency	64	1.95 GHz	ARM v8.2-A	8	Per-core: I-32KB, D-32KB
			2019. 08	7 nm	?		4 x Cortex-A55 for energy efficiency	64	1.95 GHz	ARM v8.2-A	8	Per-core: 128KB
			2019. 08	7 nm	?		4 x Cortex-A55 for energy efficiency	64	1.95 GHz	ARM v8.2-A	8	Per-core: 128KB
			2019. 08	7 nm	?		4 x Cortex-A55 for energy efficiency	64	1.95 GHz	ARM v8.2-A	8	Per-core: 128KB

power
2021
year
soc
4MB shared

Group#2

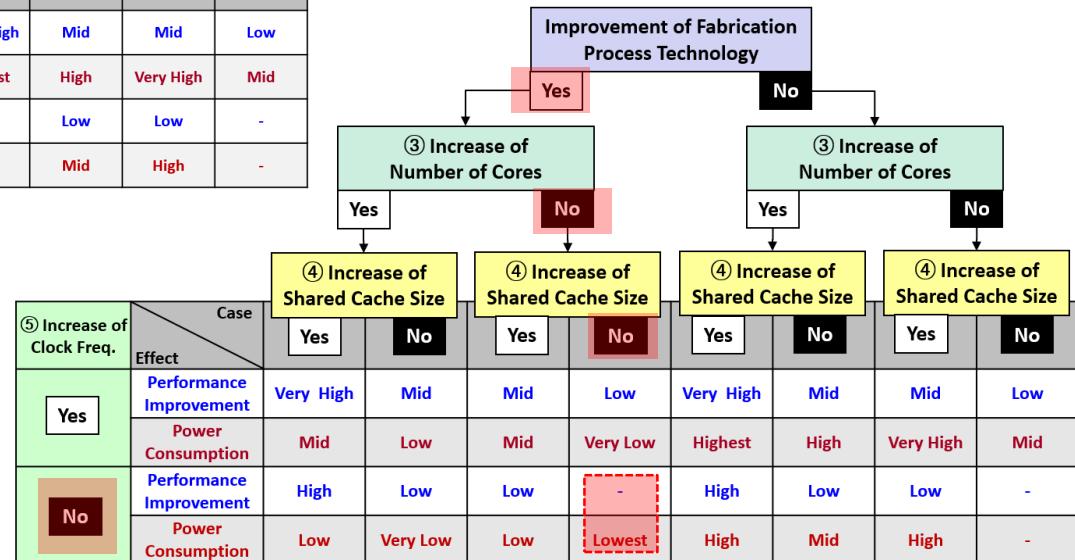
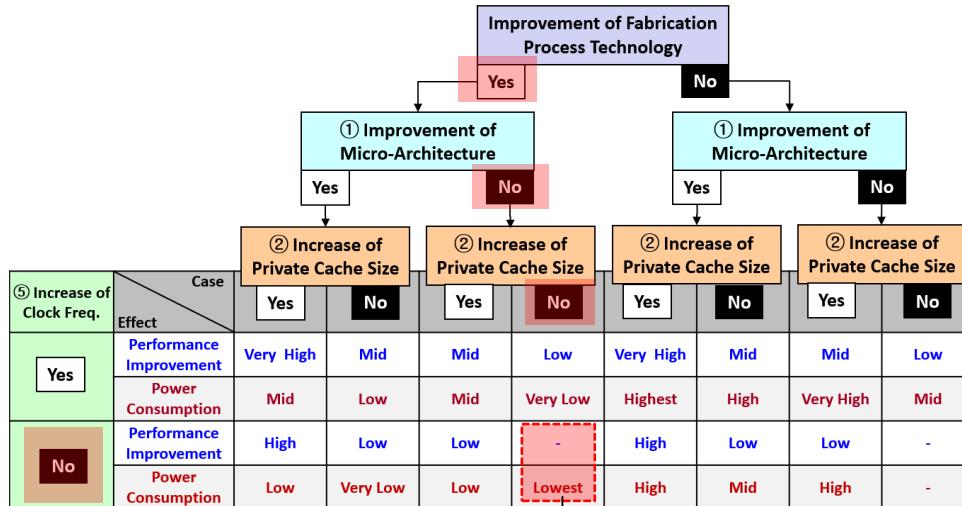
Type	Sub Type	Product Name	Release date (Year. Month)	System-on-Chip									
				Fab. Tech	Power	Name	CPU						
							Name	Intro' date (Year. Month)	Type	Spec. of Superscalar processor			
Embedded Computer Systems	Smart Phone	Galaxy S9	2018. 03	10 nm	?	Exynos 9810	4 x Meerkat (M3) for high performance	2018. ?	Super scalar	6	Yes	Yes	12
			2018. 03	10 nm	?		4 x Cortex-A55 for energy efficiency	2017. 05	Super scalar	2	No	Yes	2
		Galaxy Note10	2019. 08	7 nm	?	Exynos 9825	2 x Cheetah (M4) for high performance	2019. ?	Super scalar	6	Yes	Yes	12
			2019. 08	7 nm	?		2 x Cortex-A75 for moderate performance	2017. 05	Super scalar	3	Yes	Yes	8
			2019. 08	7 nm	?		4 x Cortex-A55 for energy efficiency	2017. 05	Super scalar	2	No	Yes	2
			2019. 08	7 nm	?		4 x Cortex-A55 for energy efficiency	2017. 05	Super scalar	2	Yes	Yes	8
			2019. 08	7 nm	?		4 x Cortex-A55 for energy efficiency	2017. 05	Super scalar	2	No	Yes	8
			2019. 08	7 nm	?		4 x Cortex-A55 for energy efficiency	2017. 05	Super scalar	2	Yes	Yes	8

micro-architecture
2021

AT&T
27/1
3/4/2021
AT&T AT&T

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#2-2 (smartphone-Galaxy)



Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#3-1 (smartphone-iPhone)

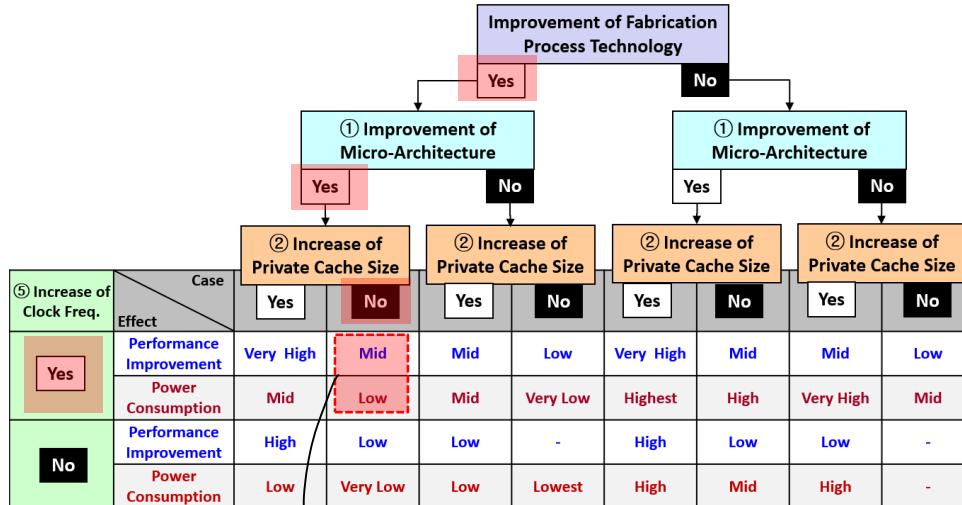
전력의 효율성을 가지고 성능을 증가시켜라.

SoC (System-on-Chip) = CPU + GPU + HW Accelerators														
Type	Sub Type	Product Name	Release date (Year. Month)	Fab. Tech	Power	Name	CPU							
							Micro-architecture	Bit-Width	Clock Freq.	ISA	No.③ of Cores	② L1 Cache Per-core: I-64KB, D-64KB	④ L2 Cache 3MB shared	L3 Cache
Embedded Computer Systems	Smart Phone	iPhone 7	2016. 09	16 nm	?	Apple A10 Fusion	2 x Hurricanes for high performance 2 x Zephyr for energy efficiency	64	2.34 GHz	ARM v8.1-A	4	Per-core: I-64KB, D-64KB	3MB shared	4MB shared by the entire SoC
		Galaxy S8	2017. 04	10 nm	?	Exynos 8895	4 x Mongoose2 (M2) for high performance 4 x Cortex-A53 for energy efficiency	64	2.3 GHz 1.7 GHz	ARM v8-A	8	Per-core: I-32KB, D-32KB	1MB shared	None
		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	2 x Monsoon for high performance 4 x Mistral for energy efficiency	64	2.39 GHz 2.42 GHz	ARM v8.2-A	6	Per-core: I-64KB, D-64KB Per-core: I-32KB, D-32KB	256KB shared 8MB shared	None

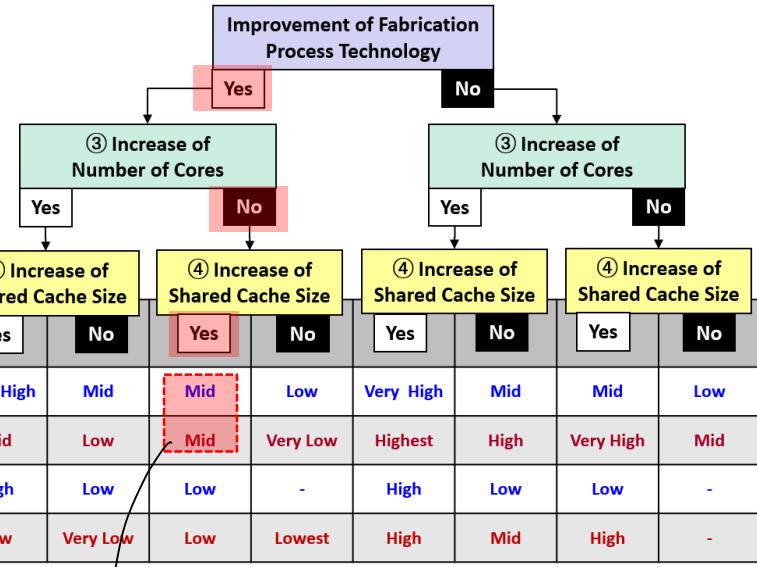
System-on-Chip														
Type	Sub Type	Product Name	Release date (Year. Month)	Fab. Tech	Power	Name	CPU							
							Name	Intro' date (Year. Month)	Type	Spec. of Superscalar processor			Pipeline depth	
Embedded Computer Systems	Smart phone	iPhone 7	2016. 09	16 nm	?	Apple A10 Fusion	2 x Hurricanes for high performance 2 x Zephyr for energy efficiency	2016. ?	Super scalar	6	Yes	Yes	9	16
		Galaxy S8	2017. 04	10 nm	?	Exynos 8895	4 x Mongoose2 (M2) for high performance 4 x Cortex-A53 for energy efficiency	2017. 02 2012. 10	Super scalar	4 2	Yes	Yes	8	13
		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	2 x Monsoon for high performance 4 x Mistral for energy efficiency	2017. ? 2017. ?	Super scalar	7 3	Yes	Yes	13 5	16 12

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#3-1 (smartphone-iPhone)



Mid
Mid
power



Mid
Mid

apple 90Hz
→ SoC 전자 모바일

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

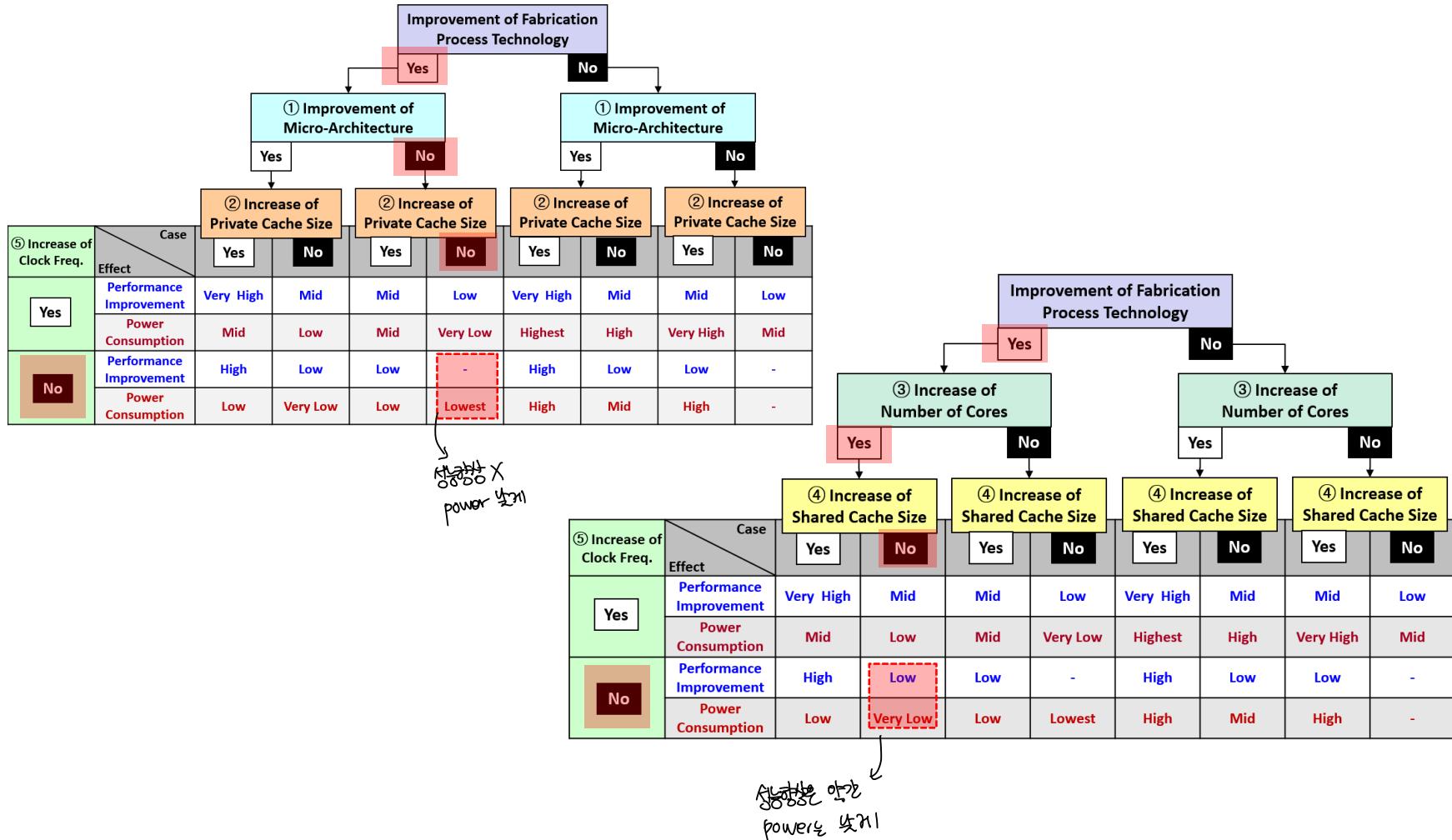
- Commercial CPU evaluation : Example#3-2 (smartphone-iPhone)

SoC (System-on-Chip) = CPU + GPU + HW Accelerators														
Type	Sub Type	Product Name	Release date (Year. Month)	Fab. Tech	Power	Name	CPU							
							Micro-architecture	Bit-Width	Clock Freq.	ISA	No.③ of Cores	② L1 Cache Per-core: I-64KB, D-64KB	④ L2 Cache	L3 Cache
Embedded Computer Systems	Smart Phone	iPhone 7	2016. 09	16 nm	?	Apple A10 Fusion	2 x Hurricanes for high performance	64	2.34 GHz	ARM v8.1-A	4	Per-core: I-64KB, D-64KB	3MB shared	4MB shared by the entire SoC
		Galaxy S8	2017. 04	10 nm	?	Exynos 8895	2 x Zephyr for energy efficiency	64	2.3 GHz	ARM v8-A	8	Per-core: I-32KB, D-32KB	1MB shared	
		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	4 x Mongoose2 (M2) for high performance	64	1.7 GHz	ARM v8.2-A	6	Per-core: I-64KB, D-32KB	2MB shared	
													None	
													None	

System-on-Chip														
Type	Sub Type	Product Name	Release date (Year. Month)	Fab. Tech	Power	Name	CPU							
							Name	Intro' date (Year. Month)	Type	Spec. of Superscalar processor				
Embedded Computer Systems	Smart phone	iPhone 7	2016. 09	16 nm	?	Apple A10 Fusion	2 x Hurricanes for high performance	2016. ?	Super scalar	6	Yes	Yes	9	16
		Galaxy S8	2017. 04	10 nm	?	Exynos 8895	2 x Zephyr for energy efficiency	2016. ?	Super scalar	3	Yes	Yes	5	12
		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	4 x Mongoose2 (M2) for high performance	2017. 02	Super scalar	4	Yes	Yes	8	13
													None	
													None	

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#3-2 (smartphone-iPhone)



Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#3-3 (smartphone-iPhone)

Group#1

Type	Sub Type	Product Name	Release date (Year. Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators									
				Fab. Tech	Power	Name	CPU		No.③ of Cores	② L1 Cache	④ L2 Cache	L3 Cache	
		Micro-architecture		Bit-Width	⑤ Clock Freq.	ISA							
Embedded Computer Systems		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	② x Monsoon for high performance 4 x Mistral for energy efficiency	64 1.42 GHz	ARM v8.2-A	6	Per-core: I-64KB, D-64KB Per-core: I-32KB, D-32KB	8MB shared 1MB shared	None
		iPhone XS	2018. 09	7 nm	?	Apple A12	② x Vortex for high performance 4 x Tempest for energy efficiency	64 1.52 GHz	ARM v8.3-A	6	Per-core: I-128KB, D-128KB Per-core: I-32KB, D-32KB	8MB shared 2MB shared	None
		iPhone 11 Pro	2019. 09	7 nm	?	Apple A13	② x Lightning for high performance 4 x Thunder for energy efficiency	64 1.82 GHz	ARM v8.4-A	6	Per-core: I-128KB, D-128KB Per-core: I-32KB, D-48KB	8MB shared 4MB shared	None

Core 개수 고려할 때
L2는 외부로

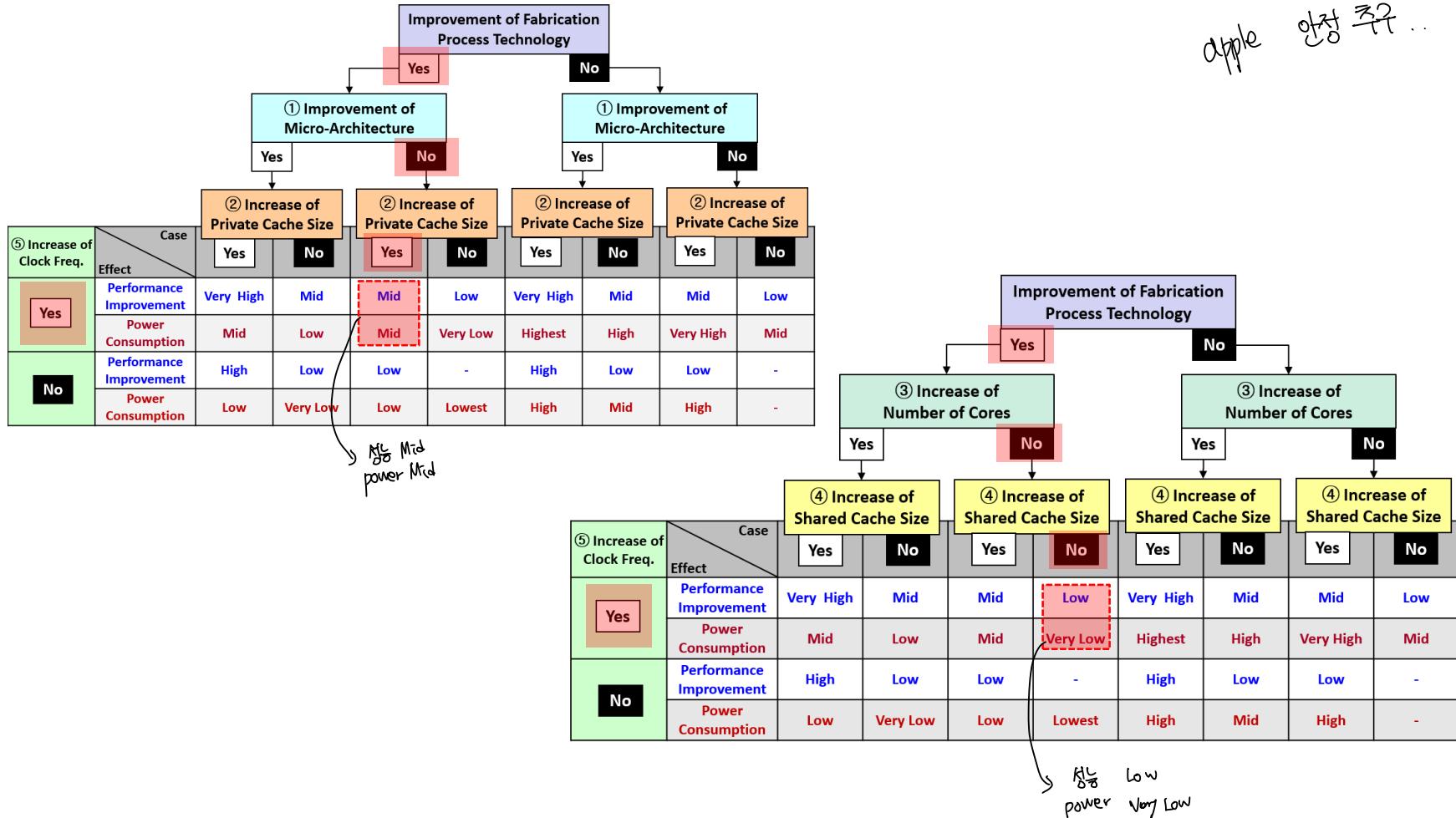
Group#1

Type	Sub Type	Product Name	Release date (Year. Month)	System-on-Chip										
				Fab. Tech	Power	Name	CPU							
							Name	Intro' date (Year. Month)	Type	Spec. of Superscalar processor			Pipeline depth	
										No. of Issues (Decodes)	Out of order execution	Branch prediction (speculation)		
Embedded Computer Systems		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	② x Monsoon for high performance 4 x Mistral for energy efficiency	2017. ?	Super scalar	7	Yes	Yes	13	16
		iPhone XS	2018. 09	7 nm	?	Apple A12	② x Vortex for high performance 4 x Tempest for energy efficiency	2018. ?	Super scalar	3	Yes	Yes	5	12
		iPhone 11 Pro	2019. 09	7 nm	?	Apple A13	② x Lightning for high performance 4 x Thunder for energy efficiency	2019. ?	Super scalar	7	Yes	Yes	13	16

Micro-architecture
설명

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#3-3 (smartphone-iPhone)



Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#3-4 (smartphone-iPhone)

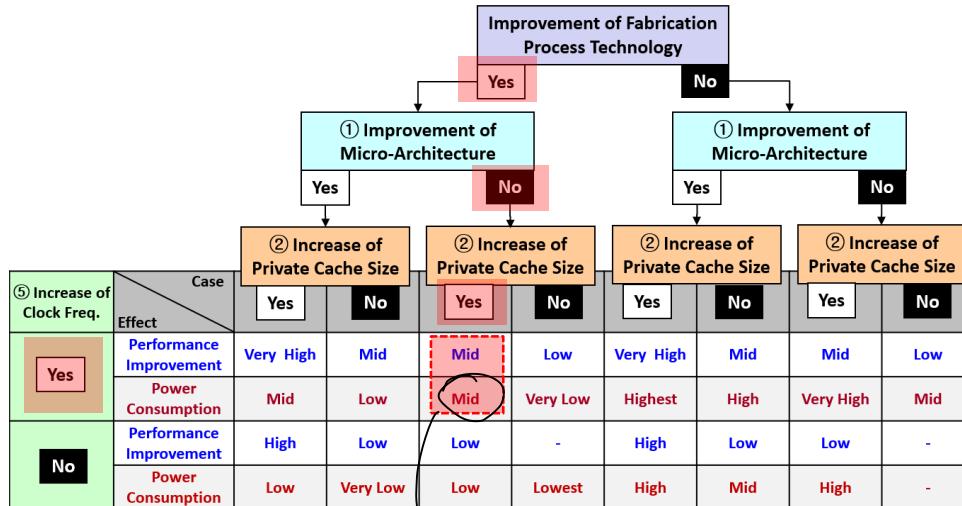
Group#1														
Type	Sub Type	Product Name	Release date (Year. Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators										
				Fab. Tech	Power	Name	CPU		ISA	No.③ of Cores	② L1 Cache	④ L2 Cache	L3 Cache	
Embedded Computer Systems		iPhone X	2017. 11	10 nm	?	Apple A11 Bionic	2 x Monsoon for high performance	64	2.39 GHz 1.42 GHz	ARM v8.2-A	6	Per-core: I-64KB, D-64KB Per-core: I-32KB, D-32KB	8MB shared 1MB shared	None
		iPhone XS	2018. 09	7 nm	?	Apple A12	2 x Vortex for high performance 4 x Tempest for energy efficiency	64	2.49 GHz 1.52 GHz	ARM v8.3-A	6	Per-core: I-128KB, D-128KB Per-core: I-32KB, D-32KB	8MB shared 2MB shared	None
		iPhone 11 Pro	2019. 09	7 nm	?	Apple A13	2 x Lightning for high performance 4 x Thunder for energy efficiency	64	2.66 GHz 1.82 GHz	ARM v8.4-A	6	Per-core: I-128KB, D-128KB Per-core: I-32KB, D-48KB	8MB shared 4MB shared	None

↳ Shows X3 vs X4 4-core vs 6-core L2 cache size

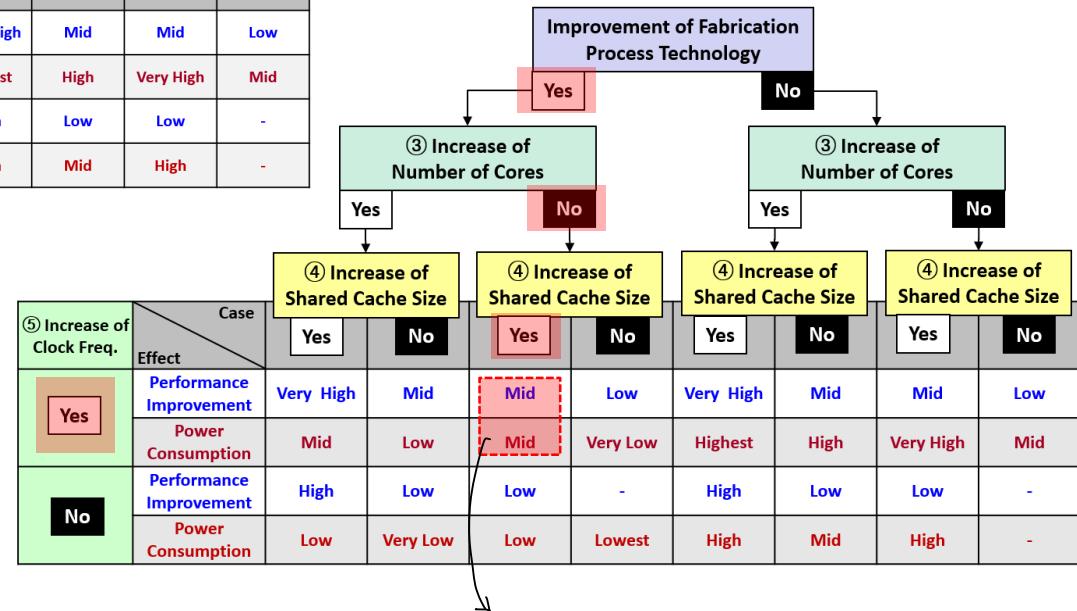
Group#1														
Type	Sub Type	Product Name	Release date (Year. Month)	System-on-Chip										
				Fab. Tech	Power	Name	CPU				Pipeline depth			
Embedded Computer Systems		iPhone X	2017. 11	10 nm	?		① Micro-architecture	Name	Intro' date (Year. Month)	Type	Spec. of Superscalar processor		Pipeline depth	
		iPhone XS	2018. 09	7 nm	?	Apple A12	2 x Vortex for high performance 4 x Tempest for energy efficiency	2017. ?	Super scalar		7	Yes	Yes	13
		iPhone 11 Pro	2019. 09	7 nm	?	Apple A13	2 x Lightning for high performance 4 x Thunder for energy efficiency	2018. ? 2018. ?	Super scalar	3	Yes	Yes	5	12

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- **Commercial CPU evaluation** : Example#3-4 (smartphone-iPhone)



powerz midz ~~mid~~
설득 mid



Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#4 (desktop)

Group#2

Type	Sub Type	Product Name	Release date (Year. Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators										
				Fab. Tech	Power	Name	CPU							(④) L3 Cache
							Micro-architecture	Bit-Width	(⑤) Clock Freq.	ISA	No. of Cores	(②) L1 Cache	(②) L2 Cache	
General PC	Desktop	SAMSUNG DB400T6B	2015. 03	14 nm	65W	Intel® Core™ i7-6700	6th Gen. Skylake	64	3.4 ~ 4 GHz	x86 -64	4	Per-core: I-32KB, D-32KB	Per-core: 256KB	8MB shared by 4 cores and GPU
		Danawa 190721	2019. 07	14 nm	95W	Intel® Core™ i7-9700K	9th Gen. Coffee Lake	64	3.6 ~ 4.9 GHz	x86 -64	8	Per-core: I-32KB, D-32KB	Per-core: 256KB	12MB shared by 4 cores and GPU

↳ intel

Group#2

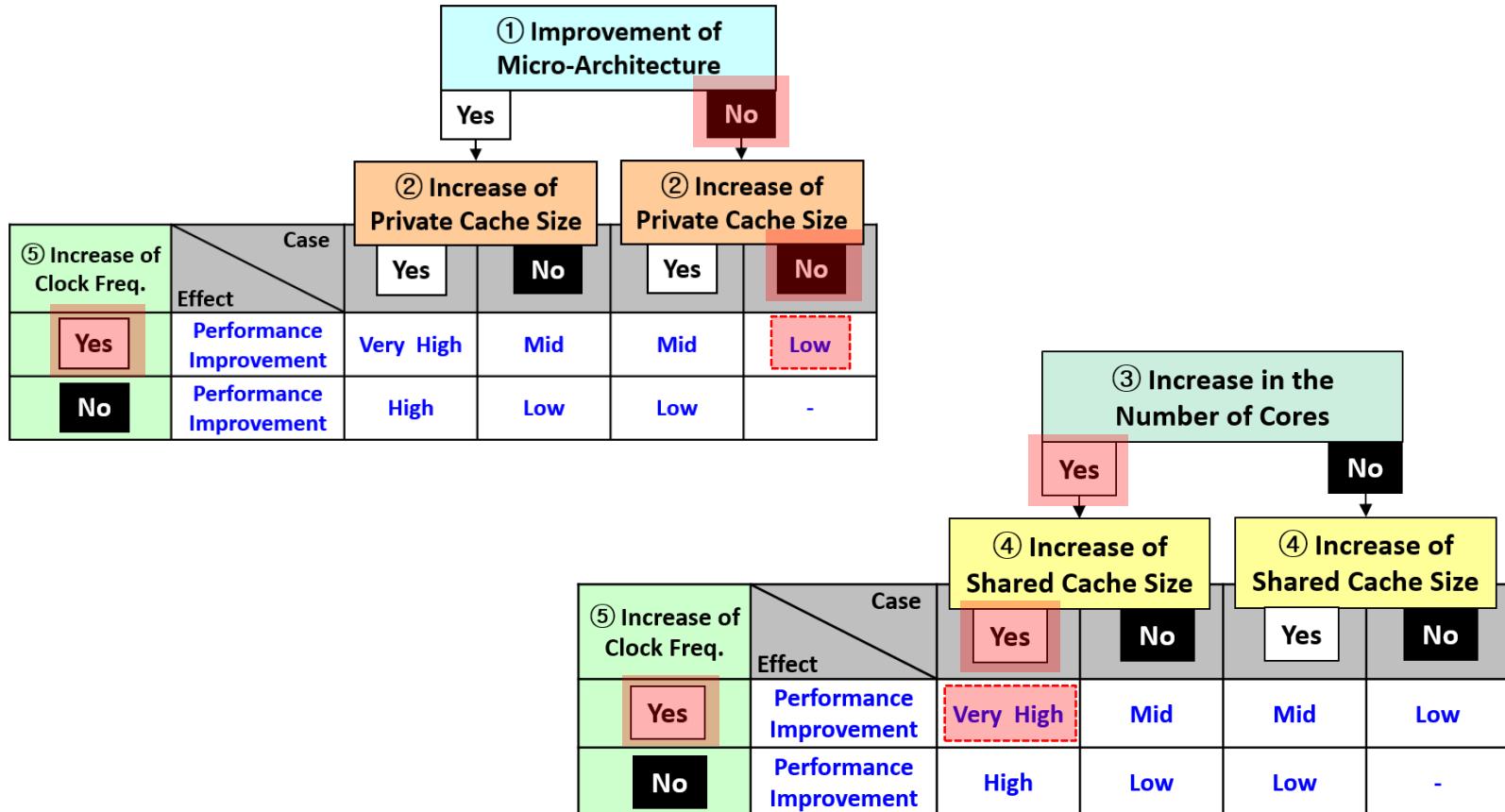
Type	Sub Type	Product Name	Release date (Year. Month)	System-on-Chip										
				CPU										
				(①) Micro-architecture										
General PC	Desktop	SAMSUNG DB400T6B	2015. 12	Fab. Tech	Power	Name	Name	Intro' date (Year. Month)	Type	Spec. of Superscalar processor			Pipeline depth	
				14 nm	65W	Intel® Core™ i7-6700	6th Gen. Skylake	2015. 08	Super scalar	5	Yes	Yes	8	14-19
		Danawa 190721	2019. 07	14 nm	95W	Intel® Core™ i7-9700K	9th Gen. Coffee Lake	2017. 10	Super scalar	5	Yes	Yes	8	14-19

↳ intel

=

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#4 (desktop)



Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#5 (workstation)

Group#2

Type	Sub Type	Product Name	Release date (Year. Month)	SoC (System-on-Chip) = CPU + GPU + HW Accelerators										
				Fab. Tech	Power	Name	CPU						③ ISA	
							Micro-architecture	Bit-Width	⑤ Clock Freq.	ISA	③ No. of Cores	② L1 Cache	② L2 Cache	④ L3 Cache
Server/ Workstation	High performance Workstation	Lenovo ThinkStation P500TW 850W	2015. 07	22 nm	140W	Intel® Xeon ® E5-1630 v3	Haswell	64	3.7 ~ 3.8 GHz	x86 -64	4	Per-core: L-32KB, D-32KB	Per-core: 256KB	10MB shared by 4 cores
		TYAN TAKO-KQT44	2020. 04	14 nm	150W	Intel® Xeon Gold 6226R	Cascade Lake	64	2.9 ~ 3.9 GHz	x86 -64	16	Per-core: L-32KB, D-32KB	Per-core: 1MB	22MB shared by 16 cores

→ Info

Group#2

Type	Sub Type	Product Name	Release date (Year. Month)	System-on-Chip										
				Fab. Tech	Power	Name	CPU							
							① Micro-architecture				Spec. of Superscalar processor			
Server/ Workstation	High performance Workstation	Lenovo ThinkStation P500TW 850W	2015. 07		22 nm	140W	Intel® Xeon ® E5-1630 v3	Haswell	2013. 06	Super scalar	4	Yes	Yes	8
		TYAN TAKO-KQT44	2020. 04		14 nm	150W	Intel® Xeon Gold 6226R	Cascade Lake	2019. ?	Super scalar	5	Yes	Yes	8 14-19

Performance-Power Consumption Metrics for Evaluating Commercial CPUs

- Commercial CPU evaluation : Example#5 (workstation)

